# SICNITICS DICTIAL UIILOEHC 2/600 TII./III DATA B00K 



TABLE OF CONTENTS

## TITLE

PAGE

## General Information

Introduction ..... 1
Package Types ..... 2

Electrical Characteristics 3
Absolute Maximum Ratings 3
NOR Gates

| SP314A | Single 7-Input | 4 |
| :--- | :--- | :--- |
| SP317A | Dual | 4-Input Expandable |

SP370A Triple 3-Input 4
SP380A Quad 2-Input 4
SP381A Quad 2-Input with Open Collector 7
OR Gates
SP333A Dual 3-Input Expandable 8
SP334A Dual 4-Input Expandable 8
SP374A Triple 3-Input 8
SP375A Triple 2-Input 8
SP384A Quad 2-input 8
$\begin{array}{lll}\text { AND Gates } & & \\ \text { SP302A } & \text { Quad 2-Input } & 11\end{array}$
$\begin{array}{lll}\text { SP304A } & \text { Dual 4-Input Expandable } & 11\end{array}$
SP305A Single 6-Input 13
SP306A Dual 3-Input 13
NAND Gates/Hex Inverters
SP337A Dual 4-Input Expandable 17
SP377A Triple 3-Input 17
SP387A Quad 2-Input 17
SP39IA Hex Inverter (Open Collector) 20
SP616A Dual 3-input Expandable 21
SP670A Triple 3-input 21
SP680A Quad 2-input 21
SP690A Hex Inverter . 21
Gate Expanders
SP300A Dual 3-input 23
SP301A Quad 2-Input 23
SP631A Quad 2-Input 23
NAND Buffer Drivers
SP352A Dual 3-Input Expandable (Open Collector) 24
SP356A Dual 4-input Expandable 26
SP659A Dual 4-Input Expandable 26
NAND Power Drivers
SP357 Quad 2-Input 28
SP358 Quad 2-Input 28
$\begin{array}{lll}\text { Master-Slave Binaries } & \\ \text { SP321A } & \text { Dual J-K } & 30\end{array}$
SP322B Dual J-K 30
SP620A Single J-K 32
D-Type Binary
SP328A Dual 34
RS/T Flip-Flop
SP629A Single 36
Shift Register
SP3271A 4-Bit 38
Counter/Storage Elements
SP3280A BCD Decade 40
SP3281A 4-Bit Binary 40
Pulse Shapers
362A Monostable Multivibrator : 42
Zero Crossing Detector
SP363A Dual
44
Applications Information46
Digital SURE Program ..... 73
Sales Office List ..... 76

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- Greater than 1-volt DC Noise Margins
- Popular 5V Supply Voltage Characterizations


## INTRODUCTION

UTILOGIC II is an improved version of Signetics original UTILOGIC family which was introduced in 1964. New devices and features in UTILOGIC II include dual in-line plug-in package, two J-K binaries, a dual D binary, a complete complement of OR, NOR, AND, and NAND gates, as well as buffer line drivers, a one shot, and a zero crossing detector.

The proven performance of the earlier UTILOGIC family, including greater than 1 volt noise margins and high capacitive drive capability has been retained. The simplicity of the Signetics silicone package provides inherently low cost in both manufacturing and subsequent handling by the user. The reliability of the Signetics silicone package has been proved by over five years of exhaustive testing. A copy of the Signetics package reliability report is available on request.

The SP600A family of compatible DTL elements is a new addition to this handbook. It affords the designer a choice of pull-up resistor values for the NAND gates as well as additional logic functions.

UTILOGIC II and SP600 elements are available in the popular $0^{\circ} \mathrm{C}$ to $75^{\circ} \mathrm{C}$ range and are designed to operate on $a V_{c c}=5 \mathrm{~V} \pm 10 \%$ power supply.

The suffix A signifies the 14 -pin dual in-line package; the suffix $B$ signifies the 16 -pin dual in-line package.

The UTILOGIC II family consists of the following elements:

## NOR Gates

| 314A | Single 7-Input NOR Gate |
| :--- | :--- |
| 317A | Dual 4-Input Expandable NOR Gate |
| 370A | Triple 3-Input NOR Gate |
| 380A | Quad 2-Input NOR Gate |
| 381A | Quad 2-Input NOR Gate (Open-Collector) |

OR Gates

| 333A | Dual 3-Input Expandable OR Gate |
| :--- | :--- |
| 334A | Dual 4-Input Expandable OR Gate |
| 374A | Triple 3-Input OR Gate |
| 375A | Triple 2-Input Expandable OR Gate |
| 384A | Quad 2-Input OR Gate |

333A
334A
374A
375A
384A

## AND Gates

| 302A | Quad 2-Input AND Gate |
| :--- | :--- |
| 304A | Dual 4-Input AND Gate (Expandable) |
| 305A | Single 6-Input AND Gate |
| 306A | Dual 3-Input AND Gate |

NAND Gates

```
337A Dual 4-Input Expandable NAND Gate
377A
387A
391A
Triple 3-Input NAND Gate
Quad 2-Input NAND Gate
Hex Inverter (Open Collector)
```

Gate Expanders

| 300 A | Dual 3-Input Expander for OR and NOR <br> Gates <br> Quad 2-Input Diode Expander for NAND <br> Gates |
| :---: | :--- |

Buffer Drivers

| 352A | Dual 3-Input Expandable NAND <br> Buffer Driver (Open Collector) <br> 356A |
| :---: | :--- |
| Dual 4-Input Expandable NAND <br> Buffer Driver |  |
| 357A | Quad 2-Input NAND Power Driver <br> Quad 2-Input NAND Power Driver <br> (Open-Collector) |

## Binaries

| 321A | Dual J-K Binary |
| :--- | :--- |
| 322A | Dual J-K Binary |
| 328A | Dual D Binary |

Pulse Shapers

| 362A | Monostable Multivibrator |
| :--- | :--- |
| 363A | Dual Zero Crossing Detector |

Shift Register

```
3271B 4-Bit Shift Register
```


## Counters

| 3280A | BCD Decade Counter |
| :--- | :--- |
| 3281A | 4-Bit Binary Counter |

The SP600 family consists of the following elements:

## NAND Gates

```
616A Dual 4-Input Expandable NAND Gate
670A Triple 3-Input NAND Gate
680A Quad 2-Input NAND Gate
```


## Line Driver

## 659A Dual 4-Input Buffer/Driver

## J-K Binary

620A | Single J-K Binary

## RS/T Binary

629A ${ }^{\text {| }}$ Single RS/T Binary

## Inverter

690A
Hex Inverter

## Expander

631A
Gate Expander

## LOADING DEFINITIONS

UTILOGIC II and SP600 loads are classified as "sink loads," or current out of the load inputs, and as "source loads," or current into the load inputs. The standard sink load is the input of a UTILOGIC II AND gate. The standard source load is the input of a UTILOGIC II NOR gate. See the loading chart or specification sheets for specific values.

## NOISE MARGINS

Signetics specifies noise immunity on UTILOGIC II and SP600 gates in terms of DC margins determined under worst case conditions for both the " 0 " and " 1 " levels. The margin for a " 1 " input applies to negative-going noise on the high level or on the power supply line. The margin for a " 0 " input applies to positive-going noise on the low logic level or the ground line. The DC margin is defined as the difference between the worst case output level and the worst case input threshold.

For the 305/306 AND gates, maximum offset voltages, which are more appropriate to nonsaturating gates, are specified. These offset voltages ensure maintenance of high DC margins in cascaded logic configurations.

## PACKAGE TYPES



## Section Electrical Characteristics

## ELECTRICAL CHARACTERISTICS

This section contains specific test limits and test condition information for use in device evaluation and incoming inspection on D.C. and A.C. parameters.

Also included in this section are pin layouts, package information, circuit diagrams and many typical curves describing the product operating characteristics.

## ABSOLUTE MAXIMUM RATINGS

| Voltage Applied (All Terminals) | $\pm 5.5 \mathrm{~V}$ |
| :--- | ---: |
| Temperature Range | $0^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$ |
| Operating | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

Where applicable, the following notes are referenced on individual specifications.

## NOTES:

1. Pins not specifically referenced are left electrically open.
2. All voltage measurements are referenced to the ground pin.
3. Positive current flow is defined as current INTO the terminal indicated.
4. Precautionary measures should be taken to ensure current limiting per the maximum ratings, should the isolation diodes become forward biased.
5. Positive logic definition: "UP" level $=$ " 1 "; "DOWN" level = " 0 ".
6. This characteristic guaranteed by output voltage measurements.
7. Manufacturer reserves the right to make design and process improvements.
8. Capacitance $C$ includes probe and test jig.
9. For this test, the signal input (pin 2 or 13 ) is tied to -6 V through $10 \mathrm{k} \Omega$ resistor.
10. Pin 14 must be tied to most negative voltage used.
11. Standard Source Load is $180 \mu \mathrm{~A}$ and Standard Sink Load is -2.5 mA
12. $\mathrm{IEE}=$ Supply Current for $\operatorname{Pin} 1=-6 \mathrm{~V}=\operatorname{Pin} 14$

## PIN CONFIGURATION



## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Noise Immunity } \\ & \text { for "1" } \\ & \text { for "0" } \end{aligned}$ | See Note 6 | $\begin{array}{r} 1100 \\ 600 \end{array}$ | $\begin{aligned} & 1700 \\ & 1000 \end{aligned}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| Output Voltage "1" Level <br> " 0 " Level | $\begin{aligned} & I_{\text {out }}=-2 \mathrm{~mA}, V_{\text {in }}=1.2 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}, V_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA}, V_{\text {in }}=2.7 \mathrm{~V} \end{aligned}$ | 3.8 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & V \\ & V \\ & V \end{aligned}$ |
| Input Current input high | $V_{\text {in }}=2.7 \mathrm{~V}$ |  |  | 180 | $\mu \mathrm{A}$ |
| Power Supply Current output high output low | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\text {in }}=4.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  | 13.4 | $\begin{array}{r} 0.3 \\ 18.1 \end{array}$ | $\mathrm{mA} /$ gate mA/gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 25 | 60 |  |
| Turn off Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 50 | 80 | ns |
| Fan-Out <br> -To sink loads ( $2.5 \mathrm{~mA} / \mathrm{load}$ ) <br> -To source loads ( $180 \mu \mathrm{~A} / \mathrm{load}$ ) |  |  |  | 5 11 |  |
| Expander Voltage (317 only) | $\mathrm{V}_{\text {in }}=2.7 \mathrm{~V}$ | 1.85 |  |  | V |

[^0]

The following curves are normalized, when applicable, to the standard data sheet conditions.





The following curves are normalized, when applicable, to the standard data sheet conditions.






NOR GATE
SP381A Quad 2-Input with Open Collector

## PIN CONFIGURATION



## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Leakage Current "1" Level | $\mathrm{V}_{\text {out }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {in }}=0.9 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| Output Voltage "O' Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| Input Current Input high | $V_{\text {in }}=2.7 \mathrm{~V}$ |  |  | 180 | $\mu \mathrm{A}$ |
| Power Supply Current Output high Output Iow <br> Turn on Delay | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=4.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ <br> See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $\begin{aligned} & 13.4 \\ & 25 \end{aligned}$ | $\begin{array}{r} 0.3 \\ 18.1 \\ 60 \end{array}$ | mA/gate mA/gate ns |
| Fan-Out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) |  |  |  | 5 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

SCHEMATIC DIAGRAM


TEST CIRCUIT AND WAVEFORM


SP374A Triple 3-Input
SP375A Triple 2-Input
SP384A Quad 2-Input

## PIN CONFIGURATIONS



ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Immunity <br> for " 1 " <br> for " 0 " | See Note 6 See Note 6 | $\begin{array}{r} 1100 \\ 600 \end{array}$ | $\begin{aligned} & 1700 \\ & 1000 \end{aligned}$ |  |  |
| Output Voltage "1" Level <br> " 0 " Level | $\begin{aligned} & I_{\text {out }}=-2 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=1.2 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=1.2 \mathrm{~V} \end{aligned}$ | 3.8 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & V \\ & V \\ & V \end{aligned}$ |
| Input Current input high | $V_{\text {in }}=2.7 \mathrm{~V}$ |  |  | 180 | $\mu \mathrm{A}$ |
| Power Supply Current output high output low | $\begin{aligned} & \mathrm{V}_{\text {in }}=4.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 11.0 \\ & 11.2 \end{aligned}$ | $\begin{aligned} & 14.7 \\ & 15.2 \end{aligned}$ | $\mathrm{mA} /$ gate $\mathrm{mA} /$ gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 50 | 80 | ns |
| Turn off Delay | See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 40 | 70 | ns |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) <br> -To source loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 5 11 |  |
| Expander Voltage (333/334/335 only) | $\mathrm{V}_{\text {in }}=2.7 \mathrm{~V}$ | 1.85 |  |  | V |

[^1]

## TEST CIRCUIT AND WAVEFORM.



The following curves are normalized, when applicable, to the standard data sheet conditions.



## PIN CONFIGURATION

(and 2-INPUT

## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Immunity "1" Level <br> " 0 " Level | See Note 6 <br> See Note 6 | $\begin{array}{r} 1400 \\ 300 \end{array}$ | $\begin{array}{r} 1800 \\ 800 \end{array}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| Output Voltage <br> "1" Level <br> "0' Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=-3 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.1 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=30 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=0.9 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=17.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=0.9 \mathrm{~V} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | V <br> V <br> V |
| Input Current <br> "1" Level <br> " 0 " Level | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=0.6 \mathrm{~V} \end{aligned}$ |  | 10 | $\begin{aligned} & 25 \\ & -2.5 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~mA} \end{aligned}$ |
| Power Supply Current Output high Output low | $\begin{aligned} & V_{\text {in }}=4.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{array}{r} 9.2 \\ 12.4 \end{array}$ | mA/gate $\mathrm{mA} /$ gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 15 | 50 | ns |
| Turn on Delay <br> Turn off Delay | See Test Figure 1, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 15 | 50 | ns |
| Fan-Out <br> -To sink loads ( $2.5 \mathrm{~mA} / \mathrm{load}$ ) <br> -To source loads ( $180 \mu \mathrm{~A} / \mathrm{load}$ ) |  |  |  | $12$ <br> 16 |  |

[^2]

TEST CIRCUIT


## SCHEMATIC DIAGRAM



TEST CIRCUIT


WAVEFORM
$\square$

## PIN CONFIGURATION

SINGLE 6-INPUT

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Offset Voltage "1" Level "0" Level | $\begin{aligned} \mathrm{I}_{\text {out }}= & -1.8 \mathrm{~mA}, V_{\text {in }}=3.8 \mathrm{~V} \\ & \text { measure } V_{\text {in }}-V_{\text {out }} \\ \mathrm{I}_{\text {out }}= & 0, V_{\text {in }}=0.6 \mathrm{~V} \\ & \text { measüre } V_{\text {in }}-V_{\text {out }} \end{aligned}$ |  |  | 0.15 -0.3 | $V$ $V$ |
| Input Current input high input low | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=0.6 \mathrm{~V} \end{aligned}$ |  | 10 | $\begin{aligned} & 40.0 \\ & -2.5 \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~mA} \end{aligned}$ |
| Power Supply Current output high output low | $\begin{aligned} & V_{\text {in }}=4.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 0.9 \\ & 2.9 \end{aligned}$ | mA/gate <br> mA/gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{A}=25{ }^{\circ} \mathrm{C}$ |  | $15$ | $50$ | ns |
| Turn off Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  |  | 60 | ns |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) <br> -To source loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 0 10 |  |

[^3]
## SCHEMATIC DIAGRAM

$\square$
Component Values are Typical

## TEST CIRCUIT AND WAVEFORM



Figure 1

The following curves are normalized, when applicable, to the standard data sheet conditions.





NAND GATES
SP337A Dual 4-Input Expandable SP377A Triple 3-Input SP387A Quad 2-Input

## PIN CONFIGURATIONS



QUAD 2-INPUT


387A

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Immunity <br> for " 1 " <br> for " 0 " | See Note 6 See Note 6 | $\begin{aligned} & 800 \\ & 300 \end{aligned}$ | $\begin{array}{r} 1200 \\ 600 \end{array}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| Output Voltage <br> "1" Level <br> " 0 " Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=-1.08 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=0.9 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=30 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.1 \mathrm{~V} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & V \\ & V \\ & V \end{aligned}$ |
| Input Current input high input low input low (expander) | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=0.6 \mathrm{~V} \\ & V_{\text {in }}=1.1 \mathrm{~V} \end{aligned}$ |  | 10 | $\begin{array}{r} 25 \\ -2.5 \\ -2.5 \end{array}$ | $\mu \mathrm{A}$ <br> mA <br> mA |
| Power Supply Current output high output low | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=4.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{array}{r} 2.8 \\ 12.8 \end{array}$ | $\mathrm{mA} /$ gate <br> $\mathrm{mA} /$ gate |
| Turn on Delay Turn off Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ <br> See Test Figure $1, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ |  | $\begin{aligned} & 22 \\ & 22 \end{aligned}$ | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} / \mathrm{load}$ ) <br> --To source loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 12 6 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.


The following curves are normalized, when applicable, to the standard data sheet conditions.




## PIN CONFIGURATION



ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Leakage Current "1" Level | $\mathrm{V}_{\text {out }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {in }}=1.2 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| Output Voltage " 0 " Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=45 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=27 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \end{aligned}$ |  |  | 0.6 0.4 |  |
| Input Current "1" Level | $v_{\text {in }}=2.7 v$ |  |  | 180 | $\mu \mathrm{A}$ |
| Power Supply Current Output high Output low | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=4.0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | 2 | $\mathrm{mA} /$ gate $\mathrm{mA} /$ gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 25 | 50 | ns |
| Fan-Out -To sink loads ( $2.5 \mathrm{~mA} / \mathrm{load}$ ) |  |  |  | 18 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

## SCHEMATIC DIAGRAM



TEST CIRCUIT AND WAVEFORM


NAND GATES
SP616A Dual 3-Input Expandable SP670A Triple 3-Input SP680A Quad 2-Input SP690A Hex Inverter

## PIN CONFIGURATION



ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Noise Immunity for "1" for " 0 " | See Note 6 <br> See Note 6 | $\begin{aligned} & 800 \\ & 300 \end{aligned}$ | $\begin{array}{r} 1200 \\ 600 \end{array}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| Output Voltage "1" Level "0" Level | $\begin{aligned} & V_{\text {in }}=0.9 \mathrm{~V}, I_{\text {out }}=260 \mu \mathrm{~A} \\ & V_{\text {in }}=2.7 \mathrm{~V}, \mathrm{I}_{\text {out }}=20 \mathrm{~mA} \\ & V_{\text {in }}=2.1 \mathrm{~V}, \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & V \\ & v \\ & v \end{aligned}$ |
| Input Current <br> input high <br> input low input low (expander) | $\begin{aligned} & v_{i n}=5.0 \mathrm{~V} \\ & v_{i n}=0.6 \mathrm{~V} \\ & v_{\text {in }}=1.1 \mathrm{~V} \end{aligned}$ |  |  | $\begin{array}{r} 25 \\ -2.5 \\ -2.5 \end{array}$ | $\mu \mathrm{A}$ <br> mA <br> mA |
| Power Supply Current output high output low | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{in}}=4.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | 2.8 9.0 | mA/gate mA/gate |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 25 | 65 | ns |
| Turn off Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 40 | 70 |  |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) <br> -To source loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 8 1 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.


PIN CONFIGURATION


## 300 GATE EXPANDER

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. |
| :--- | :---: | :---: | :---: | :---: |
| Expansion Output Voltage | $\mathrm{V}_{\text {in }}=2.7 \mathrm{~V}, \mathrm{I}_{\text {out }}=-3.0 \mathrm{~mA}$ |  |  |  |
| $(620 \Omega$ to Gnd.) |  |  |  |  |
| Fan-in Expansion of 317 | See Text (Page 49) Under <br> NOR Gates | 1.85 |  |  |

## 301, 631 GATE EXPANDER

## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| "1" Input Current | $\mathrm{V}_{\text {in }}=5.0 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |
| Diode Forward Voltage | 1 Forward $=2.5 \mathrm{~mA}$ |  |  | 0.9 | V |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

## SCHEMATIC DIAGRAM



SCHEMATIC DIAGRAM


NAND BUFFER DRIVER<br>SP352 A Dual 3-Input Expandable<br>(Open Collector)

PIN CONFIGURATION


SP352A

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temp. Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Noise Immunity } \\ & \text { for" "1" } \\ & \text { for " } 0 \text { " } \end{aligned}$ | See Note 6 <br> See Note 6 | $\begin{aligned} & \text { N.A. } \\ & 300 \end{aligned}$ | $\begin{aligned} & \text { N.A. } \\ & 600 \end{aligned}$ |  | mV |
| Output <br> "1" Level Leakage <br> " 0 ' Level Voltage | $\begin{aligned} & \mathrm{V}_{\text {in }}=0.9 \mathrm{~V}, \mathrm{~V}_{\text {out }}=5.0 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=45 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.7 \mathrm{~V} \\ & \mathrm{I}_{\text {out }}=27 \mathrm{~mA}, \mathrm{~V}_{\text {in }}=2.1 \mathrm{~V} \end{aligned}$ |  | 40 | $\begin{array}{r} 100 \\ 0.6 \\ 0.4 \end{array}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| Input Current input high input low input low (expander) | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=0.6 \mathrm{~V} \\ & V_{\text {in }}=1.1 \mathrm{~V} \end{aligned}$ |  | 5 | $\begin{array}{r} 25 \\ -2.5 \\ -2.5 \end{array}$ | $\mu \mathrm{A}$ mA mA |
| Power Supply Current output high output low | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=4.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{array}{r} 2.8 \\ 16.7 \end{array}$ | mA/gate <br> mA/gate |
| Turn on Delay | See Test Figure 1, Output to $R_{0}$ connected $T_{A}=25^{\circ} \mathrm{C}$ |  |  | 60 | ns |
| Turn off Delay | See Test Figure 1, Output to $\mathrm{R}_{\mathrm{O}}$ connected $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 90 | ns |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) <br> -To source loads ( $180 \mu \mathrm{~A} / \mathrm{load}$ ) |  |  |  | 18 N.A. |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.


NAND BUFFER DRIVERS
SP356A Dual 4-Input Expandable
SP659A Dual 4-Input Expandable

## PIN CONFIGURATION



ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)


Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.


## TEST CIRCUIT AND WAVEFORM



D252


D252

Figure 1

The following curves are normalized, when applicable, to the standard data sheet conditions.


```
NAND POWER DRIVERS
SP357 Quad 2-Input
SP358 Quad 2-Input
```


## PIN CONFIGURATION



ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5, 7 and 9)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Noise I mmunity } \\ & \text { for " } 1 \text { " [357] } \\ & \text { for "0" } \end{aligned}$ | See Note 6 <br> See Note 6 | $\begin{aligned} & 800 \\ & 300 \end{aligned}$ |  |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| ```Output "1" Level Leakage [358] "1" Level Voltage [357] "0'' Level Voltage``` | $\begin{aligned} & V_{\text {in }}=.9 \mathrm{~V}, V_{\text {out }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=.9 \mathrm{~V}, \mathrm{I}_{\text {out }}=-2.0 \mathrm{~mA} \\ & V_{\text {in }}=2.1 \mathrm{~V}, \mathrm{I}_{\text {out }}=70 \mathrm{~mA} \\ & V_{\text {in }}=2.7 \mathrm{~V}, \mathrm{I}_{\text {out }}=100 \mathrm{~mA} \end{aligned}$ | $3.5$ |  | $\begin{gathered} 100 \mu \mathrm{~A} \\ .4 \\ .6 \end{gathered}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| Input Current Input high Input low | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & V_{\text {in }}=.6 \mathrm{~V} \end{aligned}$ |  |  | $\begin{array}{r} 25 \\ -2.5 \end{array}$ | $\mu \mathrm{A}$ mA |
| Power Supply Current Output High Output Low <br> Turn-on Delay <br> Turn-off Delay [357] | $\begin{aligned} & V_{\text {in }}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \\ & V_{\text {in }}=4.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ <br> See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> See Test Figure $1, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ |  |  | $\begin{array}{r} 3.5 \\ 18.5 \\ 50 \\ 50 \end{array}$ | mA/gate $\mathrm{mA} /$ gate ns ns |
| Fan-out <br> -To source load ( $180 \mu \mathrm{~A} /$ load) <br> -To sink load ( $2.5 \mathrm{~mA} /$ Load) |  |  |  | $\begin{aligned} & 11 \\ & 40 \end{aligned}$ |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

## SCHEMATIC DIAGRAM



## TEST CIRCUIT AND WAVEFORM



D252

Figure 1
DUAL J-K BINARY

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage <br> "1" Level <br> " 0 " Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=-1.65 \mathrm{~mA} \\ & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA} \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & v \\ & v \\ & v \end{aligned}$ |
| Input Current input high |  |  |  |  |  |
| - $\underline{C}$ and $\bar{R}_{D}$ | $V_{\text {in }}=5.0$ |  | 20 | 100 | $\mu \mathrm{A}$ |
| (321) $-\overline{S_{D}}$ | $V_{\text {in }}=5.0$ |  | 10 | 50 | $\mu \mathrm{A}$ |
| $\pm J$ and $K$ | $V_{\text {in }}=5.0$ |  | 5 | 25 | $\mu \mathrm{A}$ |
| (322) $-\left[C, \overline{R_{D}}\right.$ and $\overline{S_{D}}$ | $V_{\text {in }}=5.0$ |  | 10 | 50 | $\mu \mathrm{A}$ |
| $J$ and $K$ <br> input low | $V_{\text {in }}=5.0$ |  | 5 | 25 | $\mu \mathrm{A}$ |
| $\mathrm{C} \text { and } \overline{R_{D}}$ | $v_{\text {in }}=0.6$ |  |  | -6.2 | mA |
| (321)- $\overline{S_{D}}$ | $V_{\text {in }}=0.6$ |  |  | -3.1 | mA |
| J and K | $V_{\text {in }}=0.6$ |  |  | -1.6 | mA |
| (322) $\int \frac{C}{C}, \overline{R_{D}}$ and $\overline{S_{D}}$ | $V_{\text {in }}=0.6$ |  |  | -3.1 | mA |
| (322) J and K | $V_{\text {in }}=0.6$ |  |  | -1.6 | mA |
| Power Supply Current | $\mathrm{V}_{\text {in }}=4.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 28.2 | mA/binary |
| Turn on Delay | See Test Figure 1, $\mathrm{TA}_{A}=25^{\circ} \mathrm{C}$ |  |  |  |  |
| Clocked Mode | See Test Figure 1, $\mathrm{TA}^{\text {a }}=25^{\circ} \mathrm{C}$ |  | 25 | 50 | ns |
| Direct Mode | See Test Figure 2, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 25 | 50 | ns |
| Turn off Delay Clocked Mode | See Test Figure 1, $\mathrm{TA}_{\text {A }}=25^{\circ} \mathrm{C}$ |  | 25 |  |  |
| Direct Mode | See Test Figure 2, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $25$ | 50 | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| Fan-out |  |  |  |  |  |
| -To sink loads ( $2.5 \mathrm{~mA} /$ gate) |  |  |  | 5 |  |
| -To source loads ( $180 \mu \mathrm{~A} /$ gate) |  |  |  | 9 |  |

[^4]

## LOGIC DIAGRAM



TRUTH TABLES

| $J$ | $K$ | $\alpha_{n+1}$ |
| :---: | :---: | :---: |
| 0 | 0 | $\mathrm{a}_{n}$ |
| 1 | 0 | 1 |
| 0 | 1 | 0 |
| 1 | 1 | $\bar{\alpha}_{n}$ |


| $\overline{S_{D}}$ | $\overline{R_{D}}$ | $Q$ |
| :---: | :---: | :---: |
| 0 | 0 | $*$ |
| 1 | 0 | 0 |
| 0 | 1 | 1 |
| 1 | 1 | No change |

*Both $Q$ and $\bar{Q}$ in " 1 " State.
321/322

## TEST CIRCUIT AND WAVEFORMS



Figure 1
TEST CIRCUIT AND WAVEFORMS


## MASTER-SLAVE BINARY <br> SP620A Single J-K

## PIN CONFIGURATION



## SP620A

## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)


Typical Values are for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

## SCHEMATIC DIAGRAM



TRUTH TABLES

| J | K | Q | $S_{D}$ | $R_{\text {D }}$ | Q |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Q | 0 | 0 | 0 |
| 0 | 1 | 0 | 0 | 1 | 0 |
| 1 | 0 | 1 | 1 | 0 | 1 |
| 1 | 1 | $\overline{\mathrm{Q}}$ | 1 | 1 | No Change |
| Synchronous inputs at clock time |  |  |  |  |  |
| 620A |  |  |  |  |  |

TEST CIRCUIT AND WAVEFORM


LOGIC DIAGRAM


TEST CIRCUIT AND WAVEFORM
PRESET TURN ON/TURN OFF DELAY


0252

Figure 2

PIN CONFIGURATION


SP328A

## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage "1" Level "'0’' Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=-1.08 \mathrm{~mA} \\ & \mathrm{I}_{\text {out }}=17.5 \mathrm{~mA} \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| Input Current input high |  |  |  |  |  |
| clock | $\mathrm{V}_{\text {in }}=5.0 \mathrm{~V}$ |  | 20 | 50 | $\mu \mathrm{A}$ |
| data | $V_{\text {in }}=5.0 \mathrm{~V}$ |  | 10 | 25 | $\mu \mathrm{A}$ |
| $\overline{\mathrm{SD}}$ | $\mathrm{V}_{\text {in }}=5.0 \mathrm{~V}$ |  | 20 | 50 | $\mu \mathrm{A}$ |
| $\frac{\overline{R_{D}}}{}$ | $v_{\text {in }}=5.0 \mathrm{~V}$ |  | 30 | 75 | $\mu \mathrm{A}$ |
| input low clock | $\mathrm{V}_{\text {in }}=0.6 \mathrm{~V}$ |  |  | -3.2 | mA |
| data | $V_{\text {in }}=0.6 \mathrm{~V}$ |  |  | -1.6 | $m A$ |
| $\overline{S_{D}}$ | $V_{\text {in }}=0.6 \mathrm{~V}$ |  |  | -3.2 | mA |
| $\overline{R_{D}}$ | $V_{\text {in }}=0.6 \mathrm{~V}$ |  |  | -4.8 | mA |
| Power Supply Current | $V_{\text {in }}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 14 | 19 | $\mathrm{mA} / \mathrm{binary}$ |
| Turn on Delay | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 25 | 75 | ns |
| Turn off Delay | See Test Figure $1, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ |  | 30 | 75 | ns |
| Input Pulse Width for clock, $\overline{S D}$ and data |  | 40 |  |  | ns |
| Fan-out |  |  |  |  |  |
| -To sink loads ( $2.5 \mathrm{~mA} /$ load) |  |  |  | 7 |  |
| -To source loads ( $180 \mu \mathrm{~A} / \mathrm{load}$ ) |  |  |  | 6 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.


LOGIC DIAGRAM


## TRUTH TABLES



TEST CIRCUIT AND WAVEFORM


Clock Pulse:
Amplitude $=4.0 \mathrm{~V}$, P.W. $=$
$200 \mathrm{~ns}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}, \mathrm{f}=2 \mathrm{MHz}$.
D Input:
Amplitude $=4.0 \mathrm{~V}$, P.W. $=500 \mathrm{~ns}$,
$t_{r}=t_{f}=5 n s, f=1 \mathrm{MHz}$.
Figure 1

RS/T FLIP-FLOP
SP629A Single

## PIN CONFIGURATION



SP629A

ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage "1" Level | $I_{\text {out }}=-200 \mu \mathrm{~A}$, Driven Input | 3.8 |  |  | V |
| " 0 ' Level | $\mathrm{I}_{\text {out }}=20 \mathrm{~mA}$, Driven Input |  |  | 0.6 | V |
|  | $\mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}$ Driven Input |  |  | 0.4 |  |
| Input Current input high |  |  |  |  |  |
| SD, RD, clock | $V_{\text {in }}=5.0 \mathrm{~V}$ |  |  | 25 | $\mu \mathrm{A}$ |
| $\mathrm{S}_{\mathrm{C}}, \mathrm{R}_{\mathrm{C}}$ input low | $\mathrm{V}_{\text {in }}=5.0 \mathrm{~V}$ |  |  | 25 | $\mu \mathrm{A}$ |
| $S_{D}, R_{D}, S_{C}, R_{C}$ | $\mathrm{V}_{\text {in }}=0.6 \mathrm{~V}$ |  |  | -2.5 | mA |
| Clock Effective Capacitor |  |  | 75 |  | pF |
| Power Supply Current | $\mathrm{V}_{\text {in }}=5.0 \mathrm{~V}, \mathrm{~T}_{\text {A }}=25^{\circ} \mathrm{C}$ |  |  | 10 | mA |
| Turn on Delay clocked | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  |  | 100 | ns |
| direct | See Test Figure 2, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 100 | ns |
| Turn off Delay clocked | See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 100 | ns |
| direct | See Test Figure 2, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 100 | ns |
| Fan-out |  |  |  |  |  |
| -To sink loads |  |  |  | 8 |  |
| ( $2.5 \mathrm{~mA} / \mathrm{load}$ ) |  |  |  |  |  |
| -To source loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 1 |  |

Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

SCHEMATIC DIAGRAM


## TEST CIRCUIT AND WAVEFORM

## TRUTH TABLES

| 629A |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{S}_{\mathrm{C}}$ | ${ }^{R} \mathrm{C}$ | Q | $S_{D}$ | $\mathrm{R}_{\mathrm{D}}$ | Q |
| 0 | 0 | ? | 0 | 0 | * |
| 0 | 1 | 1 | 0 | 1 | 1 |
| 1 | 0 | 0 | 1 | 0 | 0 |
| 1 | 1 | No Change |  | 1 | No Change |
| CLOCK SET/RESET |  |  | DIRECT SET/RESET |  |  |



TEST CIRCUIT AND WAVEFORM



Max. clock fall time $=75 \mathrm{~ns}$

Figure 2

SHIFT REGISTER SP3271B 4-Bit

## PIN CONFIGURATION



SP3271B

## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5, 7 and 9)

Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTICS | TEST CONDITIONS INPUTS |  |  |  |  | OUTPUTS | LIMITS |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Load | Shift | Data Inputs | Clock | Reset |  | Min. | Typ. | Max. |  |
| Output Voltage <br> "1" Level <br> "Ọ"' Level | 2.1 V 2.1 V 2.7 V | 0.9 V 0.9 V 0.9 V | 2.1 V 0.9 V 0.9 V | Pulse <br> Pulse <br> Pulse | $\begin{aligned} & 2.1 \mathrm{~V} \\ & 2.1 \mathrm{~V} \\ & 2.7 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -1.08 \mathrm{~mA} \\ & 15 \mathrm{~mA} \\ & 25 \mathrm{~mA} \end{aligned}$ | 3.5 |  | $\begin{aligned} & 0.4 \\ & 0.6 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| Input Current '" ${ }^{\prime}$ ' Level |  |  |  |  |  |  |  |  |  |  |
| load | 0.6V |  |  |  |  |  | -0.1 |  | -1.2 | mA |
| shift |  | 0.6 V |  |  |  |  | -0.1 |  | -1.2 | mA |
| data input |  |  | 0.6 V |  |  |  | -0.1 |  | -1.2 | mA |
| clock |  |  |  | 0.6V |  |  | -0.1 |  | -1.2 | mA |
| reset |  |  |  |  | 0.6V |  | -0.1 |  | -1.2 | mA |
| " 1 " Level load |  |  |  |  |  |  |  |  |  | $\mu \mathrm{A}$ |
| load shift | 5.0 V | 5.0 V |  |  |  |  |  |  | 25 25 | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| data input |  |  | 5.0 V |  |  |  |  |  | 25 | $\mu \mathrm{A}$ |
| clock |  |  |  | 5.0 V |  |  |  |  | 25 | $\mu \mathrm{A}$ |
| reset |  |  |  |  | 5.0 V |  |  |  | 25 | $\mu \mathrm{A}$ |
| Power Supply Current All Bits " 0 " | OV | OV | OV | OV | OV |  |  |  | 90 | mA |
| Turn-on Delay All Binaries | See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  | 60 | ns |
| Turn-off Delay All Binaries | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  | 60 | ns |
| Clock "1' Interval | See Test Figure 1, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  | 30 |  |  | ns |
| Transfer Rate (Shift and Parallel Entry) | See Test Figure $1, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  | 10 |  |  | MHz |
| Shift or Load Set-up Time |  |  |  |  |  |  |  | 30 |  | ns |
| Data Set-up Time |  |  |  |  |  |  |  | 30 |  | ns |

Typical Values are for $T_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

SCHEMATIC DIAGRAM


TRUTH TABLE

| CONTROL STATE | LOAD | SHIFT |
| :--- | :---: | :---: |
| HOLD | 0 | 0 |
| PARALLEL ENTRY | 1 | 0 |
| SHIFT RIGHT | 0 | 1 |
| SHIFT RIGHT | 1 | 1 |

TEST CIRCUIT AND WAVEFORMS


Figure 1

## PIN CONFIGURATION

$\square$
ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS |  |  |  |  | LIMITS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Inputs |  |  |  |  | Outputs | Min | Typ | Max | Units |
|  | Data Strobe | Data Inputs | Reset | Clock 1 | Clock 2 |  |  |  |  |  |
| "1" Output Voltage <br> " 0 " Output Voltage | $\begin{aligned} & \hline 0.9 \mathrm{~V} \\ & 0.9 \mathrm{~V} \\ & 0.9 \mathrm{~V} \end{aligned}$ | 2.1 V 0.9 V 0.9 V | $\begin{aligned} & 2.1 \mathrm{~V} \\ & 2.1 \mathrm{~V} \\ & 2.1 \mathrm{~V} \end{aligned}$ | 0.6 V | Output A Output A Output A | $\begin{gathered} -1.08 \mathrm{~mA} \\ 7.5 \mathrm{~mA} \\ 12.5 \mathrm{~mA} \end{gathered}$ | 3.5 |   <br>  0.4 <br>  0.6 |  | $\begin{aligned} & V \\ & V \\ & V \end{aligned}$ |
|  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
| " 0 " Input Current <br> Data Inputs <br> Clock 1 <br> Clock 2 (BCD) <br> Clock 2 (Binary) <br> Reset <br> Strobe | 0.6 V | 0.6 V | 0.6V |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  | -1.2 | mA |
|  |  |  |  |  |  |  |  |  | -3.2 | mA |
|  |  |  |  |  | 0.6V |  |  |  | -3.2 | mA |
|  |  |  |  |  | 0.6 V |  |  |  | -1.6 | mA |
|  |  |  |  |  |  |  |  |  | -3.2 | mA |
|  |  |  |  |  |  |  |  |  | -3.2 | mA |
| " 1 " Input Current |  |  |  |  |  |  |  |  |  |  |
| Data Inputs |  | 5.0 V |  |  |  |  |  |  | 25 | $\mu \mathrm{A}$ |
| $\overline{\text { Reset }}$ |  |  | 5.0 V |  |  |  |  |  | 50 | $\mu \mathrm{A}$ |
| Clock 1 |  |  |  | 5.0 V |  |  |  |  | 50 | $\mu \mathrm{A}$ |
| Clock 2 (BCD Counter) |  |  |  |  | 5.0 V |  |  |  | 100 | $\mu \mathrm{A}$ |
| Clock 2 (Binary Counter) |  |  |  |  | 5.0 V |  |  |  | 50 | $\mu \mathrm{A}$ |
| Strobe | 5.0 V |  |  |  |  |  |  |  | 25 | $\mu \mathrm{A}$ |
| Power Supply Current | OV | OV | OV | OV | OV |  |  |  | 52 | mA |
| Clock Mode Ton Delay (any bit) | See T | Figure | $T_{A}=25$ |  |  |  |  |  | 50 | ns |
| Clock Mode Toff Delay (any bit) | See T | Figure | $\mathrm{T}_{A}=25$ |  |  |  |  |  | 50 | ns |
| $\begin{aligned} & \text { DATA/STROBE Ton Delay } \\ & \text { (any bit) } \end{aligned}$ | See T | Figure | $\mathrm{T}_{\mathrm{A}}=25$ |  |  |  |  |  | 50 | ns |
| DATA/STROBE Toff Delay (any bit) | See T | Figure | $T_{A}=25$ |  |  |  |  |  | 50 | ns |
| Toggle Rate | See T | Figure | $\mathrm{T}_{A}=25$ |  |  |  | 15 | 25 |  | MHz |
| $\xrightarrow[\text { STROBE Hold Time }]{ }$ |  | 2.7 V | 2.7 V | 2.7 V | Output A |  |  | 20 | 50 | ns |
| RESET Hold Time |  | 2.7 V | 2.7 V | 2.7 V | Output A |  |  | 20 | 50 | ns |

[^5]

TEST CIRCUIT AND WAVEFORM(Clock Mode Ton $_{\text {on }} / T_{\text {off }}$ Delay)


INPUT PULSE:
P.A. $=4.0 \mathrm{~V}$
P.W. $=100 \mathrm{~ns}$
$t_{r}=t_{f}=10 \mathrm{~ns}$
$\mathrm{PRR}=5 \mathrm{MHz}$


Figure 1

## TEST CIRCUIT AND WAVEFORM(Data/Strobe $T_{\text {on }} / T_{\text {off }}$ Delay)



INPUT PULSE
$\overline{\text { STROBE }}$
P.A. $=4.0 \mathrm{~V}$
P.W. $=50 \mathrm{~ns}$
$\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=10 \mathrm{~ns}$
DATA
P.A. $=4.0 \mathrm{~V}$
$\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=10 \mathrm{~ns}$


Figure 2

TEST CIRCUIT AND WAVEFORM(Toggle Rate)



INPUT PULSE
P.A. $=4.0 \mathrm{~V}$
$\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=10 \mathrm{~ns}$


Figure 3

PIN CONFIGURATION


ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3,5 and 7)
Standard Conditions: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Noise Immunity } \\ & \text { for " } 0 \text { "' } \\ & \text { for " } 1 \text { " } \end{aligned}$ | See Note 6 See Note 6 | $\begin{aligned} & 800 \\ & 800 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 1200 \end{aligned}$ |  | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{mV} \end{aligned}$ |
| Output Voltage <br> "1"' Level <br> ' ${ }^{\prime}$ ' Level | $\begin{aligned} & \mathrm{I}_{\text {out }}=360 \mu \mathrm{~A}(\mathrm{Y} \text { and } \bar{Y}) \\ & \mathrm{I}_{\text {out }}=12.5 \mathrm{~mA}(\mathrm{Y} \text { and } \bar{Y}) \\ & \mathrm{I}_{\text {out }}=7.5 \mathrm{~mA}(\mathrm{Y} \text { and } \bar{Y}) \end{aligned}$ | 3.5 | $\begin{aligned} & 0.4 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 0.6 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & V \\ & V \\ & v \end{aligned}$ |
| Trigger Input Current input high input low | $\begin{aligned} & V_{\text {in }}=5.0 \mathrm{~V} \\ & v_{\text {in }}=0 \mathrm{~V} \end{aligned}$ |  | 100 | 10 | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| Turn off Delay (Y) | $\begin{aligned} & \text { See Test Figure } 1, I_{\text {out }}= \\ & 360 \mu \mathrm{~A} T_{A}=25^{\circ} \mathrm{C} \end{aligned}$ |  | 45 | 75 | ns |
| Turn or Delay ( $\bar{Y}$ ) | $\begin{gathered} \text { See Test Figure } 1, \mathrm{I}_{\text {out }}= \\ 12.5 \mathrm{~mA} \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{gathered}$ |  | 35 | 55 | ns |
| Power Supply Current $Y_{\text {out }}=1$ | $\mathrm{R}_{\mathrm{X}}$ to $5.0 \mathrm{~V}, \mathrm{R}_{\mathrm{T}}=0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ |  |  | 19.0 | mA |
| Fan-out <br> -To sink loads ( $2.5 \mathrm{~mA} /$ load) <br> -To source loads ( $180 \mu \mathrm{~A} / \mathrm{load}$ ) |  |  |  | 5 2 |  |

Typical Values are for $T_{A}=25$ c. See Page 3 for Notes.

## SCHEMATIC DIAGRAM



## TEST CIRCUIT AND WAVEFORM



Figure 1

Use the following equations to obtain a desired pulse width:
A. with internal resistor $R_{x}$ connected to $V_{c c}$ :

$$
\mathrm{PW} \approx(0.85)\left(\mathrm{C}_{\mathrm{x}}+\mathrm{C}_{\mathrm{int}}\right)\left(10^{-3} \mathrm{sec} / \mu \mathrm{F}\right)
$$

B. with external resistor $R_{x}^{\prime}(>1 k \Omega)$ paralleled with internal resistor $R_{x}$ connected to $V_{c c}$ :

$$
P W \approx \frac{(0.85)\left(C_{x}+C_{i n t}\right)\left(R_{x}^{\prime}\right) \mathrm{msec} / \mu F}{1.5 k+R_{x}^{\prime}}
$$

C. with external resistor $R_{x}^{\prime}\left(0.5 \mathrm{k} \Omega<\mathrm{R}_{\mathrm{x}}^{\prime}<4.7 \mathrm{k} \Omega\right)$ connected between $R_{T}$ and $V_{c c^{\prime}}$ internal resistor $R_{x}$ not connected:

$$
\mathrm{PW} \approx \frac{(0.85)\left(C_{x}+C_{i n t}\right)\left(R_{x}^{\prime}\right) \mathrm{msec} / \mu \mathrm{F}}{1.5 \mathrm{k}}
$$

where:

PW = pulse width. Pulse width tolerance using the internal resistor $R_{x}$ is about $\pm 25 \%$ (unit to unit variations). Using external timing resistor $R_{x}^{\prime}$, a tolerance of less than $\pm 10 \%$ may be obtained.
$C_{\text {int }}=$ internal capacitance, typically 30 pF .
$C_{x}=$ external capacitance in microfarads, connected between $C_{T}$ and $R_{T}$. The positive ( + ) side of $C_{X}$ must be tied to $\mathrm{C}_{\mathrm{T}}$.
$R_{X}^{\prime}=$ external resistor connected between $R_{T}$ and $\mathrm{V}_{\mathrm{cc}}$.


## ZERO CROSSING DETECTOR

SP363A Dual

## PIN CONFIGURATION



## ELECTRICAL CHARACTERISTICS (Notes 1, 2, 3, 5, 7 and 10)

Standard Conditions: $\mathrm{VCC}_{1}=\mathrm{V}_{\mathrm{CC}_{2}}=5.0 \mathrm{~V}, \mathrm{~V}_{1}=\mathrm{V}_{14}=-6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ Operating Temperature Range (Unless Noted)

| CHARACTERISTIC | TEST CONDITIONS | MIN. | TYP. | MAX . | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage "1" Level | $\begin{aligned} V \text { signal } & =-30 \mathrm{mV}, \\ \mathrm{I}_{\text {out }} & =-400 \mu \mathrm{~A} \end{aligned}$ | 3.5 |  |  | V |
| "0' Level | $\begin{aligned} V \text { signal } & =+30 \mathrm{mV} \\ \mathrm{I}_{\text {out }} & =12.5 \mathrm{~mA} \\ \mathrm{I}_{\text {out }} & =7.5 \mathrm{~mA} \end{aligned}$ |  |  | .6 .4 | V V |
| Input Current <br> Input High - Strobe <br> Signal | Note 9, V strobe $=5.0 \mathrm{~V}, \mathrm{~V}_{7}=\mathrm{V}_{3}=\mathrm{V}_{12}$ <br> $V$ signal $=100 \mathrm{mV}$ |  |  | $\begin{array}{r} 25 \\ 100 \end{array}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| Input Low - Strobe | $V$ signal $=V_{C C}$ through $10 \mathrm{~K} \Omega$ resistor, V strobe $=0.6 \mathrm{~V}$ |  |  | $-1.0$ | mA |
| Input Voltage-Timing R | $V_{7}=V_{2}=V_{13}, I_{3}=1 \mathrm{~mA}, 1_{12}=1 \mathrm{~mA}$, |  |  | 1 | $\checkmark$ |
| Uncertainty Region-Signal |  |  |  | $\pm 30$ | mV |
| Icc/Detector | $V_{7}=V_{3}=V_{12}$, Note $9, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 6.5 | mA |
| IEE | Note 12 |  |  | -13.0 | mA |
| Turn on Delay Detector | See Test Figure 1, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 85 | ns |
| Strobe to Output | See Test Figure 2, V signal $=\mathrm{V}_{\mathrm{CC}}$ through $10 \mathrm{~K} \Omega$ resistor, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 50 | ns |
| Turn off Delay Detector | See Test Figure 1, $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  |  | 65 | ns |
| Strobe to Output | See Test Figure 2, $\mathrm{V}_{\text {signal }}=\mathrm{V}_{\mathrm{CC}}$ through $10 \mathrm{~K} \Omega$ resistor, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 50 | ns |
| Fan-out |  |  |  |  |  |
| To Sink Loads ( $2.5 \mathrm{~mA} /$ load) |  |  | ; | 5 |  |
| To Source Loads ( $180 \mu \mathrm{~A} /$ load) |  |  |  | 2 |  |

[^6]
## SCHEMATIC DIAGRAM



## TEST CIRCUIT AND WAVEFORM



Figure 1

## TEST CIRCUIT AND WAVEFORM




D252
Input Pulse:
$V_{\text {IN }}$
Pulse Width $=200 n s$ at $50 \%$ Points
$t_{r}=t_{f}=10 \mathrm{~ns}$
Amplitude $V_{p}=4.0 \mathrm{~V}$

Figure 2

# Section <br> Applications Information 

## HOW TO DESIGN WITH UTILOGIC II

Information in this section gives examples of efficient system design with UTILOGIC II integrated circuits. The use of the characterization curves presented earlier for each UTILOGIC II circuit will be demonstrated here.

Interfacing is discussed, including the interconnecting of UTILOGIC II and other circuit types. Typical interfacing techniques are illustrated.

Some of the features of UTILOGIC II that make the family especially interesting to the systems engineer are:

1. High noise immunity, a major design consideration where application may be in high ambient noise environments that are encountered in industrial control equipment, computer peripherals, etc.
2. Low output impedance, essential for good noise immunity, also provides high DC fan-out capabilities. Switching times are relatively unaffected by the increased load capacitance associated with high fan-outs or long inter-connecting lines.
3. Single power supply to provide economy in power supply costs. Tolerance to voltage variations ( $\pm 10$ percent) permit the use of simply regulated supplies for further economy.
4. Availability of OR, AND, NOR and NAND logic functions permits straightforward design approaches which means shorter design times and lower package count.
5. Direct interface of UTILOGIC II to TTL MSI devices ensures that the latest complex functional arrays are available to the designer along with the economy, reliability and simplicity of the UTILOGIC II logic elements.

All members of the UTILOGIC II family have built-in protection against damage produced by momentary short circuit conditions, valuable during debugging or troubleshooting procedures. Any input or output connection of any UTILOGIC II element may be connected to the input, output, supply voltage, or ground connection of any other UTILOGIC II element momentarily, without producing damage to either circuit. It is not recommended that UTILOGIC II elements be connected so that they produce conditions designated as abnormal for periods of time that can be measured in seconds. If the devices are required to operate for extended periods of time under other than recommended conditions, precautions should be taken to limit the current to safe values within the device's dissipation capabilities.

## GENERAL DESIGN CONSIDERATIONS

The normal good design practices that are commonly used in layout of networks of any digital circuit family should also be applied to UTILOGIC II networks. Although all of the UTILOGIC II elements have excellent noise margins, any circuit, discrete or integrated, will produce erroneous results if the noise levels become high enough. As in any system, ground, DC distribution, and noise problems should be considered from the very beginning of the design.

A major consideration with integrated circuits is the higher packaging density, as compared to discrete devices. For example, a printed circuit board that held 3 or 4 discrete flip-flops can now hold 30 to 40 integrated flip-flops; the design of the DC and ground distribution systems must allow for the corresponding current increases. DC and ground lines should be kept as short as possible and of adequate cross-section, and the use of tantalum or other high-frequency type by-pass capacitors is recommended.

The effect of the high circuit density on system cooling requirements and the increased possibility of localized hot spots must also be considered.

Signal leads should be kept as short as possible to minimize cross-talk, noise pick-up, and propagation time down the wire.

Generally, it becomes important to terminate signal lines when the signal propagation time down the wire becomes appreciable as compared to the signal transition times. Since UTILOGIC II rise and fall times are on the order of 10 ns , lead lengths of 2 to 3 feet should not require any special termination. The simple termination network shown in Figure 1 has been found effective at any UTILOGIC II input with lines up to 12 feet in length, and with coaxial cable as well as open wire.

When using a clock distribution system which has several branches, all flip-flops should be driven from the same relative position on the branches. In addition, the clock drivers should be as close as possible to the flip-flops that they will trigger so that the driving lines are short and uniform in length.

## TERMINATION NETWORK



Figure 1

## UTILOGIC II CIRCUITS

UTILOGIC II inputs are classified as sink loads and source loads by the direction of current flow required to activate the input. The input of the OR and NOR gates are called source loads because they must be driven by a source of current, e.g., the output of a UTILOGIC II element in the " 1 " state or a connection to the positive supply. The inputs of the AND gates, NAND gates and the Binary are called sink loads because they must be driven from a current sink: for example, the output of a UTILOGIC II element in the " 0 " state or a connection to ground.

In this publication, and all other UTILOGIC II literature, the convention of positive logic, i.e., the positive level is " 1 ", has been assumed. If the negative logic notation is assumed (most negative level is " 1 "), the AND, OR, NAND and NOR gates become OR, AND, NOR and NAND respectively.
The characteristic curves presented in the various sections are designed to allow the system designer to predict system performance characteristics for various operating conditions. In general, characteristics are normalized to the conditions of the specification sheets. The use of the normalized characteristic is a definite design aid in that it is usually the change in the characteristic as a result of a change in the parameter that is of interest.

As long as the effects, e.g.,

$$
\frac{\partial V_{\text {sat }}}{\partial T_{\text {emp }}}
$$

are small, the total effect may be predicted by taking the product of the individual effects.
Throughout the discussion that follows, $\mathrm{V}_{\mathrm{cc}}$ is assumed to be 5.0 V unless otherwise specified.

## UTILOGIC II NOR Gates and Expander

The UTILOGIC II NOR gates (314, 370, and 380), Expandable NOR gate (317) and Expander (300), are all derived from the same basic circuit to ensure full compatibility of the Expandable Gates and Expander, and to give all the circuits identical electrical characteristics. However, the 300 and 317 will have longer turn-off delay times ( $T_{2}$ ) because of the additional capacitive loading on the expansion input. Turn-on delays ( $\mathrm{T}_{1}$ ) are not sensitive to this capacitance because the source impedance is low during turn-on.

The 300 Expander circuit is characterized in terms of its operation in conjunction with the 317 Expandable NOR and 333 Expandable OR. The ways in which 300 and 317
(as well as 300 and 333) compatibility is guaranteed are of interest. The expansion forward voltage for the 300 and the expansion input voltage of the 317 are measured under the same conditions, and the same limits are guaranteed. In addition, the 300 input leakage current and the 317 " 0 " input current specifications guarantee reverse current compatibility. These specifications assure the user that the 300 and 317 or the 300 and 333 combination will have the same DC characteristics as when the 317 or 333 is used alone. AC characteristics are shown later (with the 317 and 333 curves) as a function of the capacitance on the expansion input.

## CIRCUIT DESCRIPTION

The UTILOGIC II NOR gate (page 4) may be considered as a derivation of the DTL NOR gate. The input diodes of the DTL NOR were replaced with transistors to decrease the input current to allow larger source fan-out capabilities from the NOR and other circuits in the family. The NOR employs a totem-pole output to obtain low output impedance in both the " 1 " and " 0 " states. The switching thresholds are determined by the ratio of the coupling resistance to the pull-down resistance at the base of each switching transistor. The series resistor at the output provides current-limiting should the output become accidentally shorted to ground. The Expandable NOR is implemented by connecting the common emitters of the input transistors to an expansion input. The Expander (page 23) is a dual array of input transistors; thus, the effect of connecting the Expander output to an expansion input is the same as connecting more input transistors in parallel.

## Input Characteristics

The Standard UTILOGIC II Source Load is the NOR input. The Standard Source Load may be simulated by a $15 \mathrm{k} \Omega$ resistor and 2 series silicon diodes to ground. An unused NOR input should be tied to ground through a resistance of $60 \mathrm{k} \Omega$ (or less) or connected in common with a used input on the same circuit. The capacitance of an open input may become charged during prolonged " 1 " levels at a driven input. When the driven input goes from " 1 " to " 0 ", the charged capacitance discharges into the input and gives the effect of a slow circuit. Two or more common inputs represent the same DC load as a single input since the " 1 " input current is determined by the voltage across the coupling resistors and the gain of the input transistors. Neither of these values changes appreciably when inputs are connected in common. The additional capacitance of a commoned input has no measurable effect on switching times. Input voltages should not exceed the supply voltage unless precautions are taken to limit the resulting current to 30 mA in the input transistor collector-base junction.

## Output Characteristics

A UTILOGIC II NOR gate has a fan-out of 5 sink loads and 11 source loads. All 16 loads may be connected simultaneously because they do not interact. Because the NOR gates employ transistors for both pull-up and pull-down, their outputs cannot be connected with the output of any other independent circuit (collector-logic). Such operation of an active pull-up device with another device may result in ambiguous output voltages and/or excessively high currents if one device should attempt to reach a " 1 " level while the other is attempting to reach a level " 0 ". However, two NORs may be connected with common inputs and common outputs. In this case, fan-out is doubled and the input loading is two Standard Source Loads.

## UTILOGIC II OR Gates

The UTILOGIC II OR gates are compatible on a pin for pin basis with their UTILOGIC II NOR gate counterparts. This simplifies system design, circuit board layout and checkout. Comparison of the schematics of the UTILOGIC II OR gate (page 8 through 10) and the UTILOGIC II NOR gate (page 4) shows that both types of gates have essentially identical input and output structures; however, the OR gate uses one more transistor to obtain the additional inversion required to produce an OR gate from the basic UTILOGIC II NOR configuration.

## UTILOGIC II AND Gates

The UTILOGIC II AND gates 305 and 306 are fabricated from the same basic chip, and therefore have identical electrical characteristics. The internal connection pattern is varied to produce a single 6 -input AND gate in the 305, and the dual 3-input AND gates in the 306.

## CIRCUIT DESCRIPTION

Schematic diagrams of the UTILOGIC II AND gates are shown on page 13. The multiple-emitter input structure provides the same function as a Diode AND gate. The output-emitter follower provides the current gain necessary for high fan-out, and also reduces the offset voltage associated with Diode AND gates. The emitter follower provides a low output impedance to effect fast response on " 0 " to " 1 " transistions and the current gain necessary for source current fan-out. The input transistor and connecting diode provide a low impedance circuit to maintain good response on " 1 " to " 0 " transitions.

## Input Characteristics

The input of the AND is defined as a standard UTILOGIC II sink load. The standard sink load may be simulated by 2 $\mathrm{k} \Omega$ resistor with a series silicon diode to the supply voltage. The input impedance of UTILOGIC II AND gates is low enough so that unused inputs may be left open without degrading circuit performance (open inputs are logical " 1 ") however; it is recommended that unused inputs be connected to the used inputs of the circuit. Connecting the unused inputs to used inputs of the same circuit will not increase the circuit loading. The effect of the added capacitance will be negligible.

## Output Characteristics

The fan-out of the UTILOGIC II AND gate is 10 to standard UTILOGIC II source loads. The AND gate does not have output current sinking capability; therefore, it cannot drive sink loads. The AND gate can drive any of the UTILOGIC II source loads. The AND gate outputs should not be paralleled with the outputs of any other circuits as in collector logic configurations. However, outputs of AND gates may be connected to increase fan-out if the inputs of the two circuits are in common.

## UTILOGIC II NAND Gates and Expander

The UTILOGIC II NAND gates (337, 377 and 387) and diode expander (301) are DTL gates. This is due to the fact that the basic UTILOGIC input structure does not lend itself to implementing the NAND function. The NAND gates are compatible with all other elements in the UTILOGIC II line. In addition, the NAND gates provide a guaranteed interface with Signetics TTL logic elements.
The 301 expander is specified under the same conditions as the gate inputs, thus ensuring that an expanded 337 will have the same input characteristics as the other NAND gates. The 301 may also be used as an expander for the 356 driver element.

## CIRCUIT DESCRIPTION

The UTILOGIC II NAND gates (page 17) are modifications of the proven Signetics 600 series circuits. The major change is that the usual $4 \mathrm{k} \Omega$ output resistor has been replaced with a $1 \mathrm{k} \Omega$ resistor. The use of a passive pull-up permits outputs to be connected in parallel to perform collector logic. Input and output levels are fully compatible with the other UTILOGIC elements and provide a minimum of 800 mV of noise margin in both the " 0 " and " 1 " states.

## Input Characteristics

The input structure of the NAND gates makes them sink loads. The NAND inputs, like the UTILOGIC II AND inputs, require that the driving gate to be able to sink 2.5 mA for each such load driven. The UTILOGIC OR and NOR gates can therefore drive up to 5 NAND gate inputs. As with the AND gates, the input load of the NAND gates may be simulated by a $2 \mathrm{k} \Omega$ resistor in series with a silicon diode to the supply voltage.

Unused inputs may be left open, however, a more conservative design practice suggests connecting the unused inputs to a driven input. In cases where the source load on the driving gate will not permit connecting the unused inputs to a driven input, the unused inputs may be returned to $\mathrm{V}_{\mathrm{cc}}$.
The UTILOGIC II NAND gates have two sets of input and output specifications to enable the NAND gates to be used with both UTILOGIC elements and Signetics TTL logic elements. The " 1 " level input threshold is specified at 2.7 volts for use with UTILOGIC driving elements and 2.1 volts for use with TTL driving elements. This is accomplished by reducing the fan-out at the lower input voltage. The " 0 " level input current in both cases is within the 2.5 mA maximum.

## Output Characteristics

A UTILOGIC II NAND gate has a fan-out of 12 loads and 6 source loads. All 18 loads may be connected simultaneously. The passive $1 \mathrm{k} \Omega$ pull-up resistor used in the NAND output structure permits collector logic to be performed by connecting the outputs of up to 5 NAND gates in paralle. The resulting "wired AND" gate can drive one sink load and 6 source loads.
In cases where additional fan-out may be required, NAND gates may be connected in parallel. The fan-out can be doubled by connecting two gates in parallel; however, the input loading is also doubled.

The UTILOGIC II NAND gates can be used to drive Signetics TTL logic elements and complex arrays. When used in conjunction with TTL circuits, the NAND gate sink fan-out is reduced to 12.5 mA at a " 0 " output voltage of 0.4 volts. In most cases, this will result in a fan-out of 7 to Signetics DCL sink type loads. Refer to the Signetics DCL Handbook for further information on DCL input requirements.
The 600 Series NAND gates, as stated previously, are the same as the UTILOGIC NANDS except for the pull-up resistor which is $4 \mathrm{k} \Omega$ instead of the $1 \mathrm{k} \Omega$ used in UTILOGIC. Therefore the comments for UTILOGIC NAND* are applicable to 600 series NANDS with this one difference.

## Series 600 Inverter

The 690 Inverter has been designed using the same circuit as the 600 NAND gates and provides six inverters in each package.
The circuit description, input and output characteristics are therefore the same as those for the SP600 NAND gates.

## UTILOGIC II Buffer Driver

The UTILOGIC II 356 Buffer Driver is shown on page 26. It is intended for driving the clock and RESET lines of the 321 and 322 J -K binaries. The " 1 " level output impedance of the driver is approximately 150 ohms for output voltages less than one diode drop below $\mathrm{V}_{\mathrm{cc}}$. It should also be noted that the use of active outputs for both the " 1 " and " 0 " states means that the output of these drivers cannot be connected in parallel with any other element. However, for those cases where high fan-out is required, but absolutely no clock skew can be allowed, two line drivers may be tied in parallel if the inputs also are made common.

The 352 is an open collector variation of the 356. The open collector allows collector logic to be performed in conjunction with the driving capabilities for clock and reset lines.

## UTILOGIC II J-K Binaries

The UTILOGIC II 321 and 322 are dual J-K general purpose binaries with both synchronous and asynchronous inputs. They employ DC level triggering with clocking effected on the negative-going edge of the clock pulse waveform.

## CIRCUIT OPERATION

The 321 and 322 have the following output sequence:

1. With clock pulse low, the logical inputs are disabled and the slave is connected to the master.
2. At the rise of the clock pulse the slave is disconnected from the master and the logical inputs are enabled. Data now enters the master, setting it to the state determined by the logical inputs. The information present at the $J$ and $K$ lines prior to or coincident with the rise of the clock, sets the master FF when the clock reaches a logical " 1 " level. For reliable operation the original J and K inputs must remain stable during the entire clock " 1 " interval.
3. At the fall of the clock pulse the logical inputs are disabled to prevent entry of further information and the slave is connected to the master. The slave now takes the state of the master and state of the slave appears at the outputs. The J and K inputs of the 321 and 322 are non-inverting, that is, the flip-flop will be set at " 1 " when the J input is high and the $K$ input is low. The asynchronous inputs are inverting, that is, actuated by logical " 0 ". The effect of the asynchronous inputs is independent of the state of the clock line.

## J-K BINARY ELEMENT - 620A

The 620A is a DC-triggered, master-slave, J-K flip-flop intended for use in systems with a clock rate to 2 MHz . The circuit may be set or reset asynchronously with the $S_{D}$ and $R_{D}$ inputs, or switched synchronously by using the J and K inputs together with a clock. When it is switched asynchronously, the 620A behaves as an RS flip-flop. When it is switched synchronously, the circuit acts as a J-K flip-flop. The master and the slave flip-flops are connected by means of two AND gates. When switched synchronously, the rising clock pulse cuts the slave off from the master.

## LOGIC DIAGRAM AND TRUTH TABLES



As the clock rises still higher, it allows the logic at the J and $K$ inputs to be set into the master. Then, when the clock returns to its low level, the state of the master is transferred to the slave which, in turn, sets the output levels. The thresholds of the transfer gate and master flip-flop gates are separated by sufficient voltage to guarantee that input and transfer cannot occur simultaneously. This guarantees racefree operation. When the 620A is switched asynchronously, the master and the slave are coupled together and the outputs are set immediately. Setting should be performed with the clock line low. However, in applications such as ripple counting, in which state of the clock line cannot be predicted, setting can be accomplished by lowering the J input while raising $S_{D}$ or lowering the $K$ input while raising $R_{D}$. The $J$ and $K$ inputs should be stable during clock time. If the $S_{D} R_{D}$ inputs are not used, they should be tied down. Other unused inputs should be tied to $\mathrm{V}_{\mathrm{cc}}$.
The synchronous inputs strictly follow the definition of a J-K flip-flop. The case of $S_{D} R_{D}$ both being up will have no immediate effect on the outputs. The input which falls last will control the final state of the flip-flop. Delay through the flip-flop is typically 65 ns . The push-pull output gates minimize switching time degradation under high capacitance loads. The recommended clock pulse width is 200 ns.

## D TYPE BINARY 328

The 328 responds to the positive-going edge of the clock pulse. The logic inputs are locked out once the clock is high, thus preventing more than one transition of the binary per clock pulse.

## LOGIC DIAGRAM



## TRUTH TABLES

| $D$ $Q_{n+1}$ $\overline{\mathrm{O}}_{\mathrm{n}+1}$ <br> 1 1 0 <br> 0 0 1 |
| :---: |
|  |
| Preset <br> $\left(S_{D}\right)$ Clear $\left.^{\prime}\right)$ $Q$ <br> 1 1 0 <br> 1 0 0 <br> 0 1 1 <br> 0 0 + |
| +Both outputs in 1 state |
| $n$ is time prior to clock |
| $n+1$ is time following clock |

## RS/T BINARY ELEMENT - 629A

The 629A RS/T Binary element employs capacitively coupled clock lines for high-speed race free operation. It is intended for use in systems with clock rates to 5 MHz or in counters and shift registers to 10 MHz . Output lines are fully buffered to allow collector logic and for complete assurance that noise on driven lines will not introduce erroneous states in the flip-flop.

## TRUTH TABLES

| $\mathrm{S}_{\mathrm{C}}$ | $\mathrm{R}_{\mathrm{C}}$ | Q |
| :---: | :---: | :---: |
| 0 | 0 | $?$ |
| 0 | 1 | 1 |
| 1 | 0 | 0 |
| 1 | 1 | No Change |


| $S_{D}$ | $R_{D}$ | $Q$ |
| :---: | :---: | :---: |
| 0 | 0 | $*$ |
| 0 | 1 | 1 |
| 1 | 0 | 0 |
| 1 | 1 | No Change |

DIRECT SET/RESET

[^7]This device has input provision for both clocked ( $S_{C} / R_{C}$ ) and direct ( $S_{D} / R_{D}$ ) operation and features split clock capabilities. Both the clocked and direct inputs are energized by " 0 ' logic levels; that is, they are inverting. The inverting inputs allow implementation of AND or AND-OR control logic with one NAND level (NAND-INVERT = AND). The inverting inputs do not contribute to internal set-up time.

## SCHEMATIC DIAGRAM



Logic levels to the $\mathrm{S}_{\mathrm{C}} / \mathrm{R}_{\mathrm{C}}$ inputs should be stable at the rise of the clock pulse and should remain stable while the clock input is high. Refer to Signetics Application Note AN108 for further usage information.

The fan-out rating for the 600A family elements to the 629A clock line is derived under conditions that assure compliance with the required amplitude and fall time when operated within the power supply, temperature and fan-out ratings for the product line. All unused inputs should be tied to $\mathrm{V}_{\mathbf{c c}}$.

## 362 Multivibrator

The 362 is a one-shot multivibrator with complementary outputs and optional 500 -ohm load resistors. The output pulse width can be conveniently adjusted to conform to most one-shot application requirements. The 362 provides high output duty cycle ( $75 \%$ ) and complete isolation of the timing stage and the output stage, resulting in good fall time even with wide pulse width. The input pulse width should be at least 50 nanoseconds wide, with a fall time of less than 75 nanoseconds, or 1 volt per 25 ns.
The 362 provides complementary outputs with passive 3 k ohm pull-up resistors. An optional 500 ohm pull-up resistor is provided at each output, to be used when driving heavy capacitance loads where rise times must be maintained.

The 362 design employs a 30 pF timing capacitor and an optional 1.5 k ohm timing resistor. The output pulse width may be varied by appropriate connection of external $R$ and $C$ at the $C_{t}, R_{t^{\prime}} R_{y}$ and $R_{\bar{y}}$ terminals.

## 363 DUAL ZERO CROSSING DETECTOR

The 363 Dual Zero Crossing Detector is a circuit incorporating a differential input and logic gate output. The input amplifier is referenced to zero volts and employs temperature compensation to ensure stable thresholds.

## INTERFACING CONSIDERATIONS

## GENERAL CONSIDERATIONS

The need to interface UTILOGIC II integrated circuits with discrete component circuitry or with integrated circuits of another family may arise when a UTILOGIC II system or subsystem is added to or must operate with existing hardware. General rules when interfacing are:

1. Inputs to UTILOGIC II source loads must be capable of supplying $180 \mu \mathrm{~A}$ input current at the " 1 " input threshold voltage of at least 2.7 volts.
2. Inputs to sink loads must be capable of sinking 2.5 mA at the " 0 " voltage ( 0.6 V ).
3. A UTILOGIC II output will supply 2 mA at 3.8 volts for NOR and OR gates; it will supply 1.6 mA at 3.8 volts for binaries; and 1.8 mA at 3.8 volts for ANDs.
4. The approximate equivalent circuit for any UTILOGIC II output at " 1 " is 100 ohms to 4.0 volts. A NOR, OR and binary output will sink 12.5 mA at 0.6 volts or less.
5. The rise and fall times of signals entering a UTILOGIC system should be kept to less than $1 \mu \mathrm{sec}$ to ensure stable operation and avoid oscillation of the gate driving transition of the threshold.

## UTILOGIC II AND DTL

A UTILOGIC II-to-Signetics 100 series DTL (DTL in general) interface requires, at most, modification of load definitions. The input resistor of the DTL NAND gate and the UTILOGIC II AND are approximately the same value so that the DTL load is equal to a UTILOGIC II sink load. The " 1 " and " 0 " levels at UTILOGIC II outputs are fully compatible with DTL input requirements and vice versa.

SP600 series DTL elements that have passive pull-up outputs generally have fan-outs of 2 to UTILOGIC II source loads. Higher source load fan-out can be obtained by providing $8 \mathrm{k} \Omega$ of pull-up resistance for each additional source fan-out required. A UTILOGIC II AND gate may be used as buffer for DTL to UTILOGIC II.

Mixed UTILOGIC II - DTL systems should operate with a 5.0 volt power supply; the rules above assume a common power supply.

## UTILOGIC II AND TTL

Utilogic II/600 Series circuits are designed to interface directly with Signetics TTL integrated circuits. The inputs of the TTL devices ( 8000 Series or $54 / 7400$ Series) are multiples of 1.6 mA with an input voltage of 0.4 V . The sink current capabiltiy of the Utilogic 11 and 600 Series devices is specified at $\mathrm{V}_{\text {SAT }}=0.4 \mathrm{~V}$ and 0.6 V in order that fan-out can be calculated for either TTL or Utilogic loads respectively. Since the output voltage of all Utilogic II and 600 Series circuits with either active or passive internal pull-ups is guaranteed to be a minimum of 3.5 V , these devices will provide at least 1.5 V of " 1 " level noise margin when driving TTL loads.
For TTL driving Utilogic 11 or 600 Series circuits, the maximum " 0 " level output voltage of 0.4 V will provide up to 800 mV of guaranteed noise margin. For most Utilogic II/ 600 Series circuits, the input threshold voltage is specified at either 2.1 V or 2.7 V with corresponding differences in current sink capability. The lower figure of 2.1 V should be used when interfacing directly with TTL outputs. The guaranteed " 1 " level for the $54 / 7400$ Series is 2.4 V providing 300 mV of noise margin, while the " 1 " level output for Signetics 8000 Series circuits is 2.6 V minimum which results in 500 mV of worst case noise margin.
When driving Utilogic II OR and NOR gates with an input threshold of 2.7 V minimum a resistor should be connected between the TTL output and VCC. The resistor value should be chosen such that it maintains a " 1 " level output voltage greater than 2.7 V while supplying " 1 " level current to drive the load. The resistor must be large enough so that it does not require excessive " 0 " level current sinking capability for the TTL output structure.

## UTILOGIC II TO RTL INTERFACE

When intermixing UTILOGIC II and the higher speed TTL circuits in the same system, care should be taken to provide adequate local power supply bypassing. In addition, greater care should be taken in circuit board layout to minimize the unwanted coupling of the rise and fall time pulses associated with the TTL switching speeds. The recommended practice for use of TTL devices is to decouple the power supply with a good R-f capacitor for every 5 gate packages on a board at the rate of .01 $\mu \mathrm{f} / \mathrm{package}$. These capacitors should be located in close proximity to the gates they are to decouple.

## MISCELLANEOUS INTERFACES

For applications where input " 1 " levels are higher than UTILOGIC II " 1 " levels (" 0 " voltages about equal), several interfacing possibilities exist. A UTILOGIC II AND gate may be used as a buffer by using a series diode (d) to improve the input breakdown voltage (see Figure 3). The external resistor, ( $R$ ), may be used to improve the " 0 " offset voltage, thereby compensating for the voltage rise across the diode (each $20 \mathrm{k} \Omega$ load reduces fan-out by 1 ). High conductance diodes are recommended to keep the input voltage as low as possible.

Interfacing high " 1 " voltage outputs to UTILOGIC II source load inputs may be accomplished by techniques such as those in the following four examples. In Figure 4, the forward voltage of one or more diodes is the voltage dropping medium. In Figure 5, a zener diode is used when voltage drops of 5 volts or more must be obtained. The resistor, R, may be used to increase the zener current to improve its regulation. Using a zener as shown in Figure 5, may be especially desirable if the " 1 " level of the driving source has large variations. In Figure 6, a simple resistive voltage divider provides the necessary voltage reduction, and may be used when minor modifications to the logic levels are required and when high speeds are not necessary.

When the " 1 " level output of another logic circuit will not reach the required UTILOGIC II input level 2.7 volts, the 317 or 333 Expandable gates will often provide an acceptable buffer, shown in Figure 7. Because the voltage required to switch an Expandable Gate is a "diode drop" lower at the Expansion Input than at the regular inputs, " 1 " levels of 2.0 volts and " 0 " levels of 0.8 volts are sufficient. Maximum " 1 " input current is 3 mA . This Expansion Input interface scheme also may be used at interfaces with Diode Logic, shown in Figure 8.


Figure 2

## HIGH LEVEL TO AND INTERFACE



5 VOLT TO SOURCE INPUT INTERFACE


Figure 4



Figure 9

## TYPICAL APPLICATIONS OF UTILOGIC II

The examples in Figure 13 through 16 illustrate the versatility of the UTILOGIC II AND, OR, NAND and NOR gates and binaries in the implementation of some basic logic configurations.



## Exclusive-OR

The Exclusive-OR $(X \oplus Y)$ function, shown in Figure 17 is equivalent to the statement, "f equals $X$ or $Y$, but not both, or $X$ is not equal to $Y$." The Digital Comparator output, Figure 18, is the complement of the Exclusive-OR output and is used to implement the function, X equals Y .

## EXCLUSIVE-OR



Figure 17

DIGITAL COMPARATOR


## Collector Logic

Collector logic or "wired AND" is made possible by the use of the UTILOGIC II NAND gates. In this configuration, the outputs of two or more gates are wired together to simulate a new logic function. Thus, as illustrated in Figure 19 the function $f=\overline{A B+C D}$ is generated using only two gates.

COLLECTOR LOGIC

$f=\overline{A B}+\overline{C D}$
Figure 19
PULSE WIDTH DISCRIMINATOR


## PULSE STRETCHER



## SCHMITT TRIGGER



Figure 22

SCHMITT TRIGGER


Figure 23

## SCHMITT TRIGGER



The Schmitt triggers of figure $A$ and $B$ have a variable hysteresis voltage which is approximately equal to

$$
V_{\text {hyst }} \cong-3.7 \frac{R_{2}}{R_{1}} \text { Volts, } R_{1} \leqslant R_{2}
$$

ONE-SHOT


The one-shot of figure 25 operates in the following manner: The input pulse is differentiated by the $R, C$, network for a positive going input transition. This causes the input to the gate to appear as a logical " 1 " causing the output to rise. This is fed back to the other input thereby locking the output to a " 1 " until the voltage at the input discharges through $\mathrm{R}_{\mathrm{T}} \mathrm{C}_{\mathrm{T}}$ to the threshold region. At this point the positive feedback restores the output to a logical " 0 ".

The output pulse will have two modes:
Mode 1 - if: input p.w. <output p.w. then output p.w. = T
Mode 2 - if: input p.w. > output p.w. then output p.w. = input p.w.

This circuit is useful to overcome the contact bounce associated with mechanical to electrical interface and for signal conditioning for short pulse inputs. The same circuit can be built using two NOR gates as shown in figure 28.

ONE SHOT WITH A SCHMITT TRIGGER INPUT, RETRIGGERABLE POSITIVE EDGE TRIGGER


Figure 26

Circuit operation: When the input rises to a logical "1" level the output of gate 1 assumes a " 1 " level. This charges $\mathrm{C}_{\mathrm{T}}$ through the diode thereby presenting the input of gate 2 with a " 1 ". The output of gate 2 therefore assumes a " 1 " level. This condition holds until the input falls to the input threshold level. At this point, and until the input pulse falls to one diode drop below threshold, the $10 \mathrm{k} \Omega$ resistor feeds current into the input holding a " 1 " level output.

When the input falls to a diode drop below threshold the current through the $10 \mathrm{k} \Omega$ resistor is "bled" away from the input and the output of gate 1 falls to a logical " 0 ". $\mathrm{C}_{\mathrm{T}}$ then discharges through the effective parallel resistance until the voltage at gate 2 input reaches threshold. At this time the output falls to a logical zero. $C_{T}$ may be recharged at any point in the cycle by another pulse at the input.

RE-TRIGGERABLE ONE-SHOT WITH NEGATIVE EDGE TRIGGERING


Figure 27
ONE-SHOT WITH COMPLEMENTARY OUTPUTS

$\mathrm{T}=0.7 \mathrm{R}_{\mathrm{T}} \mathrm{C}_{\mathrm{T}}$
Figure 28
NOISE DISCRIMINATOR ONE-SHOT


Circuit Operation: This one-shot discriminates between noise lasting less than time $\Delta T_{1}$ and an input signal having a greater than $\Delta T_{1}$ duration. An input greater than $\Delta T_{1}$ produces an output pulse of $\Delta T_{2}$. The output of gate 3 is fed back into the input of gate 1 which guarantees an output pulse of $\Delta T_{2}$ if the input goes to " 0 " during the output " 1 " cycle. The diodes are used to minimize recovery time.

## LATCH AND TRUTH TABLE

Figure 30

## LATCH AND TRUTH TABLE

0252

| $R$ | S | Q | $\overline{\mathrm{Q}}$ |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 1 | 0 |
| 1 | 0 | 0 | 1 |
| 1 | 1 | No | Change |

Figure 31

SINGLE FLIP-FLOP:AND TRUTH TABLE-


## ARITHMETIC FUNCTIONS

This subsection describes four basic arithmetic functions (Half-Adder, Full-Adder, Parallel Binary Adder and Full Subtractor) and illustrates their implementation with UTILOGIC II circuits.

## HALF-ADDER

The Half-Adder (Figure 33) is a functional circuit for obtaining the binary sum of $X$ plus $Y$. The circuit has two outputs, Sum and Carry ( S and C). The Sum output is the same as the output of the Exclusive-OR circuit; the $C$ output indicates a binary carry. A Half-Adder may be used at the lowest order position of a Parallel Adder (all bits added simultaneously) since there is no carry input to this position. Two Half-Adders may be combined to obtain a Full-Adder.

## HALF ADDER



Figure 33

## FULL-ADDER

A Fult-Adder (Figure 34) is a circuit for obtaining the binary sum of three binary digits, $X, Y$, and $C$ (carry). The circuit has two outputs: $S$ to indicate the sum of the three inputs and $\overline{\mathrm{C}}$ to indicate the value of the resulting carry.
FULL ADDER AND TRUTH TABLE


Figure 34

## PARALLEL BINARY ADDER

The carry propagation delay is minimized by alternating between Carry and $\overline{\text { Carry }}$ in the carry propagation delay path as shown in Figure 35. It is necessary to alternate the polarity of inputs $A$ and $B$ from stage to stage to do this. Alternating the Q and $\overline{\mathrm{Q}}$ of the 328 flip-flop eliminates the need for inverting Sum outputs. The use of collector logic minimizes the number of gates required to perform the function.

PARALLEL BINARY ADDER


## FULL-SUBTRACTOR

The circuitry to obtain the binary Difference, ( $D$ equals $X$ minus Y minus Borrow), and $\mathrm{B}^{\prime}$ (new Borrow), is identical to the above Full-Adder, except that a false input and a change of output notation are required. The UTILOGIC'II Full-Subtractor implementation is shown in Figure 36.
FULL SUBTRACTOR


## TRUTH TABLE

| $X$ | $Y$ | $B$ | $D$ | $B^{\prime}$ |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 1 | 0 |
| 0 | 1 | 0 | 1 | 1 |
| 1 | 1 | 0 | 0 | 0 |
| 0 | 0 | 1 | 1 | 1 |
| 1 | 0 | 1 | 0 | 0 |
| 0 | 1 | 1 | 0 | 1 |
| 1 | 1 | 1 | 1 | 1 |

$$
\begin{aligned}
& \mathrm{D}=\mathrm{B}(X Y+\bar{X} \bar{Y})+\bar{B}(X \bar{Y}+\bar{X} Y) \\
& \bar{B}=\bar{X} Y+B(X Y+\bar{X} \bar{Y})
\end{aligned}
$$

## COUNTING FUNCTIONS

Since many computing functions, such as indexing and program control, are essentially counting functions, a large variety of counters is used in computing equipment. Some of the more common counter types discussed in this section showing the flexibility of the UTILOGIC 11 family are: asynchronous ripple counters, useful for frequency division; simple synchronous counters for high-speed logic operations; reversible counters for specialized control; and feedback shift registers which are especially suited for commutation and very high-speed counting.

## EXPANDABLE PARALLEL COMPARATOR

The comparator shown minimizes both package count and ripple through. The appropriate output $\left.K_{,}=,>\right)$will be a logical " 1 ", and the other two outputs will be a logical " 0 " upon completion of the comparison.

## EXPANDABLE PARALLEL COMPARATOR



| CONDITION | X | Y | Z |
| :---: | :---: | :---: | :---: |
| $\mathrm{A}=\mathrm{B}$ | 0 | 0 | 1 |
| $\mathrm{~A}<\mathrm{B}$ | 0 | 1 | 0 |
| $\mathrm{~A}>\mathrm{B}$ | 1 | 0 | 0 |

## BINARY RIPPLE COUNTERS

In ripple counters, the flip-flop normally operates in the simple toggle mode (change with each clock pulse) with the output of each element driving the clock input of the following stage. Ripple counters operating in this manner are able to operate at higher input frequencies than most other types of counters, require no gating and few interconnections, and present only one clock input to the input line. The asynchronous Set/Reset characteristics of the 321 and 322 binaries allow the binary sequence of the simple ripple counter to be modified to arbitrary sequence lengths, many of which can be obtained without gating. A limitation of all ripple counters is that a change of state may be required to ripple through the entire length of the counter. The propagation time of this change may determine the maximum operating frequency of the modified types and will be determined when any decoding networks may be sampled. A simple Binary Ripple Counter that counts up is shown in Figure 37. Since each stage changes state (complements) on each " 1 " to " 0 " transition of the previous stage, the counter is implemented by connecting the clock input of each stage to the " $Q^{\prime}$ " output of the previous stage.

Presetting to " 0 " is illustrated in the first two stages in Figure 39 , presetting to " 1 " is shown in the third stage. Figure 40 shows a ripple counter implemented with the 321 binary.
BINARY RIPPLE COUNTER


ALL GATES $1 / 4387$ EACH

## BINARY RIPPLE COUNTER - 322 BINARY IMPLEMENTATION



BINARY RIPPLE COUNTER - 321 BINARY IMPLEMENTATION


D252

Figure 40

## MODIFIED RIPPLE COUNTERS

Many popular counters are modifications of the basic Binary Ripple Counter previously described. The decimal counter modifications, shown in Figure 42 illustrate the versatility obtained by combining the ripple counting technique with logical feedback. In Figure 42 the carry provides resynchronization to the clock pulse. This technique may be applied to other similar ripple counters. It provides most of the speed advantages of ripple propagation while allowing synchronous operation between decades.

## SYNCHRONOUS COUNTERS

Synchronous counters are used in applications where all flip-flop outputs must change simultaneously, as in most high-speed logic systems and in counters that must be
decoded during counting. Synchronous counters may be used to stop an event on a specific count or may be used for timing events as a function of specific intervals in a clock pulse sequence.

## Asynchronous Divide-By-16 Up Counter

This counter (shown in Figure 41) makes use of the 328 Binary which is leading edge triggered. The clock must therefore be driven by the $\overline{\mathrm{Q}}$ output of the previous stage to perform the up count. If a down count is required, the clock must be driven by the $\mathbf{Q}$ output of the previous stage. This applies to all leading edge triggered systems.

Also, these counters are useful for special computer applications that involve reversing, special codes, and start/stop operations. Some limitations of a synchronous counter as compared to a ripple counter are:

1. Higher flip-flop fan-outs and gate fan-ins are required.
2. The clock line represents a relatively high load.

BINARY COUNTER AND TRUTH TABLES


| $A$ | $B$ | $C$ | $D$ |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 |
| 0 | 1 | 0 | 0 |
| 1 | 1 | 0 | 0 |
| 0 | 0 | 1 | 0 |
| 1 | 0 | 1 | 0 |
| 0 | 1 | 1 | 0 |
| 1 | 1 | 1 | 0 |
| 0 | 0 | 0 | 1 |
| 1 | 0 | 0 | 1 |
| 0 | 1 | 0 | 1 |
| 1 | 1 | 0 | 1 |
| 0 | 0 | 1 | 1 |
| 1 | 0 | 1 | 1 |
| 0 | 1 | 1 | 1 |
| 1 | 1 | 1 | 1 |
| 0 | 0 | 0 | 0 |

Figure 41

## BINARY COUNTER

The large fan-in capability of UTILOGIC II NOR gates allows a simple Synchronous Binary Counter to be implemented easily, as shown by the ten sample stages in Figure 43. The large fan-out capability of the $321 / 322$ binaries allows this counter to be extended to 14 stages $(16,384$ states) without buffering. The alternate implementation shown reduces:

1. The fan-out requirements of the $321 / 322$ binaries.
2. The fan-in requirements of the NOR gates.
3. The number of circuit elements when gate fan-in requirements exceed 7.

However, the operating speed is lowered because of the introduction of additional propagation delays. The counter sequence is the same for both implementations.

## MODULAR BINARY COUNTER

This type of counter, as shown in Figure 44, requires lower fan-out and fan-in than required in the previous example but at the expense of propagation delay. The maximum signal delay is through $\mathrm{N}-2$ gates for a counter of N stages. Stages may be added in a modular fashion because the logic is repetitive for each stage.

## 8-4-2-1 DECADE COUNTER WITH DECIMAL DECODING

Feedback and the J-K characteristics of the UTILOGIC II 321/322 are employed to produce the 8-4-2-1 decade counter shown in Figure 45. UTILOGIC II AND gates may be substituted for the NOR gates illustrated in the decoding matrix when sink fan-out from the decoding gates is not required and decreased propagation delays are desired.

## 4-2-2-1 DECADE COUNTER

The count sequence of the counter shown in Figure 46 is not as popular as the previously shown 8-4-2-1 sequence but is frequently used since its decimal decoding matrix requires only 3 -input gates.

## REVERSIBLE BINARY COUNTER

The counter shown in Figure 47 will count every input pulse. The counter will count up when the UP input is low; it will count down when the DOWN input line is low.

## REVERSIBLE DECADE COUNTER

The counter shown in Figure 48 uses feedback to produce an 8-4-2-1 decade sequence. The counter will count only when the appropriate command is present.

## BCD COUNTER WITH GATED CARRY



0252

Figure 42
SYNCHRONOUS BINARY COUNTER


0252


Figure 44
BCD COUNTER WITH DECIMAL DECODING


Figure 45

## 4-2-2-1 DECADE COUNTER



REVERSIBLE BINARY COUNTER


REVERSIBLE DECADE COUNTER


## SIMPLE RING COUNTER

A very simple. Ring Counter with sequence of 6 ( N equals 3) that requires no gating is shown in Figure 49. Presetting is required to ensure that the proper sequence is entered.

## SIMPLE RING COUNTER AND TRUTH TABLE



## DECIMAL RING COUNTER WITH DECODING AND SELF-SEQUENCING

The counter in Figure 50 is essentially the above counter except that N equals 5 , and a gate has been added to provide self-sequencing. Readout gating is shown to illustrate its simplicity. UTILOGIC II AND gates may be substituted for the NOR decoding gates when sink fan-out from the decoding gates is not required, and decreased propagation times are desired.

## JOHNSON COUNTER

The Johnson Counter (Feedback Shift Register) has a sequence length, $2^{N}-1$, for most small $N(N$ equals the number of stages). However, for some $N$, the sequence lengths may be different. For example, when N equals 5 , one initial state (00000) gives 21 states; another (11000) gives 7; a third initial state ( 00100 ) gives 3 states. The Johnson Counter can be designed to produce sequence lengths not easily obtainable with other high-speed counter designs; however, this type of counter is hard to decode and debug since there is no common pattern to the sequence. The Johnson Counter shown in Figure 51 has a sequence length of 15 (initial state " 0000 ") as shown in the Truth Table.

## DECIMAL RING COUNTER




Figure 50

JOHNSON COUNTER AND TRUTH TABLE


$$
\begin{array}{|r|r|r|r|r|}
\hline & A & B & C & D \\
\hline 0 & 0 & 0 & 0 & 0 \\
1 & 1 & 0 & 0 & 0 \\
2 & 0 & 1 & 0 & 0 \\
3 & 1 & 0 & 1 & 0 \\
4 & 0 & 1 & 0 & 1 \\
5 & 0 & 0 & 1 & 0 \\
6 & 1 & 0 & 0 & 1 \\
7 & 1 & 1 & 0 & 0 \\
8 & 0 & 1 & 1 & 0 \\
9 & 1 & 0 & 1 & 1 \\
10 & 1 & 1 & 0 & 1 \\
11 & 1 & 1 & 1 & 0 \\
12 & 0 & 1 & 1 & 1 \\
13 & 0 & 0 & 1 & 1 \\
14 & 0 & 0 & 0 & 1 \\
0 & 0 & 0 & 0 & 0 \\
\hline
\end{array}
$$

Figure 51

## Shift Registers

A Shift Register is a circuit for storing and shifting a number of binary or decimal digits. Shift Registers frequently are used in arithmetic operations to accomplish multiplication or division; they also are used to present information in serial form for use in displays, adders, magnetic tapes, and magnetic drums. The Shift Register, shown in Figure 52, shifts its contents one position to the right upon each occurrence of the clock pulse. The input lines allow entry of new information to the first stage; the clear line will reset all of the stages to " 0 ". A configuration is shown in Figure 53 in which information stored at $X_{1}$, $X_{2} \ldots X_{N}$ (another shift register) is entered in parallel to register $Y\left(Y_{1}, Y_{2} \ldots Y_{N}\right)$ upon the command ENTER. Upon each command to SHIFT, the information stored in register $Y$ is shifted one stage to the right. Although the parallel entry utilizes the asynchronous inputs, the entire operation is under the direct control of the clock pulse so that the operation is synchronous.

## Feedback Shift Registers

Feedback Shift Registers or Ring Counters, like the ripplecarry counters, are capable of operating at the maximum frequency of the flip-flops; they have the additional feature of being able to shift as well as count. This characteristic is very valuable when the information in the counter is to be presented as a serial word to a display or memory device. When connected as a Ring Counter, a Feedback Shift Register will have a sequence length of 2 N ; other connections may give sequence lengths to the maximum of $2^{\mathrm{N}} \cdot 1$.

## SERIAL ENTRY SHIFT REGISTER



Figure 52

## PARALLEL ENTRY SHIFT REGISTER



Figure 53

## SERIAL-IN, PARALLEL-OUT

In Figure 54, shift registers are implemented with RS/T, J-K, or D binaries


Figure 54

## LEFT RIGHT SHIFT REGISTER

The left-right shift register will shift either one bit to the left, or one bit to the right for each clock pulse. The register will shift to the left if the L-R line is logical " 0 ", and to the right if the L-R line is logical " 1 ". Data will transfer on the leading edge of the clock.

## ASYNCHRONOUS CONTROL CONFIGURATIONS

In the following asynchronous examples, the timing of the operations is controlled by internally generated signals instead of by an external clock source as in synchronous operations. The logic required to generate the timing signals may require a great deal of hardware, but the operation may be considerably faster than in an equivalent synchronous operation where the clock period must allow for the maximum circuit delays.

## SIMPLE ASYNCHRONOUS ADD SEQUENCE

The simple system shown in Figure 56 illustrates typical asynchronous techniques. In this figure, the Asynchronous Sequencer is cleared and started by the START ADD signal. The Asynchronous Sequencer immediately enables the Transfer operation, which proceeds to completion and signals the Sequencer that it is completed. The Sequencer then enables each succeeding operation in sequence, but
LEFT-RIGHT SHIFT REGISTER
only after receiving a completion signal from each signal from each previous operation. After all operations under the control of the Sequencer have been completed, an ADD COMPLETE signal is sent to the master control circuits.

## ASYNCHRONOUS SEQUENCER

The circuit shown in Figure 59 will generate the enable signals for " N " asynchronous operations. The Sequencer may be expanded where shown in order to accommodate any number of operations. Typically, the Asynchronous Sequencer will be used in combination with a similar asynchronous circuit, such as the following Shift Register with Asynchronous Transfer.

## ASYNCHRONOUS TRANSFER REGISTER

Figure 57 shows a logic configuration to asynchronously transfer information stored at locations $X_{A}, X_{B} \ldots X_{N}$ (a register) to register $Y$. Upon receipt of the command TRANSFER, the input NOR gates, which are serving as ANDs, will connect $X$ to $Y$ to allow $Y$ to assume the state of $X$. The Digital Comparators compare the state of each $Y$ position to the state at each $X$ position. When all of the positions agree, TRANSFER COMPLETE signals completion to a control circuit such as the Asynchronous Sequencer above.


## ASYNCHRONOUS SYSTEM



ASYNCHRONOUS TRANSFER


## OSCILLATORS AND MULTIVIBRATORS

A simple three stage oscillator using UTILOGIC NOR gates is shown in Figure 58 along with a graph of oscillation frequency versus capacitance.

## SIMPLE OSCILLATOR



ASYNCHRONOUS SEQUENCER


VOLTAGE CONTROLLED OSCILLATORS (Figure 60) Combining the Schmitt Trigger of Figure 24 with additional NOR logic produces the V.C.O. of Circuit A. There are three modes of operation:

Mode 1 V in open or $\mathrm{R}_{\mathrm{C}}=\infty$, fo $=1.2 \mathrm{RC}, \mathrm{R} \leqslant 10 \mathrm{k} \Omega$ C must be non-polarized
Mode $2 \mathrm{~V}_{\text {in }}$ connected to a voltage supply and $\mathrm{R}_{\mathrm{C}} \leqslant$ 10 k . As $\mathrm{V}_{\text {in }}$ decreases from the threshold region of Gate 1 towards a negative voltage $f_{o}$ increases; a 12:1 range of $f_{o}$ can be achieved,
Mode $3 \mathrm{~V}_{\text {in }}$ open or $\mathrm{R}_{\mathrm{C}}=\infty, f_{o}$ may be varied over a 1000:1 range by varying $R_{x}$. A variable resistor or a voltage controlled resistor (MOS FET) may be used for this application.
This circuit operates best for a $\mathrm{V}_{\text {in }}<0 \mathrm{~V}$. The diode across $R_{x}$ produces a positive going pulse at $f_{0}$. This V. C. O. can be made with one 380 package. It is self-starting and has an $f_{0} \max \cong 5 \mathrm{MHz}$.


CRYSTAL CONTROLLED OSCILLATOR


Performance data:
Crystal $f_{0}=100 \mathrm{kHz}$ to 2 MHz
$R_{W}$ controls the amount of positive feedback permitting both sinusoidal and square-wave operation.

Figure 61


Performance data:
$\mathrm{f}_{\mathrm{O}} \cong \frac{1}{2 r} ; \quad r=\mathrm{RC}$
${ }^{\dagger}{ }_{0 M A X} \cong 5 \mathrm{MHz}$
$\emptyset 1$ and $\emptyset 2$ must be $180^{\circ}$ out-of-phase at a frequency greater than $f_{0}$ and have a pulse width of less than $1 \mu$ sec.

Figure 62

## SELF - STARTING MULTIVIBRATOR

Figure 64 shows a self-starting VCO using a single Utilogic Quad 2-Input NOR package.


Performance data:
$\mathrm{f} \tilde{\overline{0}} \frac{1}{r}, r=R C$ at $V_{I N}=5 \mathrm{~V} \pm 5 \%$
If: $V_{I N}=+2.5 \mathrm{~V}$ to $+25 \mathrm{~V} ; R \leq 10 \mathrm{~K} \Omega$
Then: $f_{0}=1 f_{0}$ to $100 f_{0}$ or 100:1 range
( $f_{0}^{\prime}=V C O$ frequency)
$\mathrm{f}_{\mathrm{OMax}} \cong 5 \mathrm{MHz}$
Figure 63


## LINEAR AMPLIFIER



OPEN LOOP GAIN VS OUTPUT VOLTAGE SWING


## TRANSMISSION LINE DRIVER AND RECEIVER



There are four basic sections of this system:

Section 1 The Driver is a D-type latch producing complemented outputs using 380 NOR Gates.

Section 2 A shielded twisted - pair n-feet in length.

Section 3 The 150 ohm Line Termination - Delta configuration. The 1.7 K resistor in parallel with 300 pF and in series with 300 ohms between the inputs of the receiver provide an AC line termination as well as a DC load (2K ohms).

Section 4 The receiver is a 380 NOR Gate Latch.

This technique has been used to transmit and receive data up to 1500 feet on multiple conductor telephone cable.

The Signetics SURE*/883 Program consists of a combination of 100 percent and statistical sample tests designed to assure specified performance, continuing uniformity, and long term reliability of Signetics products. These tests are made regularly at no extra cost to the user and are performed in addition to the 40 quality assurance inspections and tests to which every circuit is subjected before final seal. The tests, tabulated below for the specifier's convenience, are performed in accordance with the following conditions, sequence, and schedules on equipment calibrated to meet all requirements of MIL-Q-9858A and MIL-C-45662A.

Every circuit of every lot is processed to the environmental screens shown in Table 1. These screens are performed in production and include $100 \%$ final production electrical tests. Any unit failing either the environmental screens or the final production electrical tests is rejected and removed from the lot.

After completion of Table I tests, each manufacturing lot is sampled and tested by Quality Assurance for conformance to the requirements of Table II. The unsampled portion of the lot is held pending acceptance of the lot sample. Detailed electrical test limits and conditions applicable to each subgroup are shown in the Electrical Characteristics table of the individual part type data sheets.

Tables IIIA, IIIB, and IIIC provide a complete process qualification and verification program in accordance with the conditions of MIL-STD-883, Group A, B and C tests. These tests are performed once in every 90 day manufacturing period, on representative devices from each standard production die process family and on each production package family. The representative circuits and packages selected are changed routinely, and the tests performed monitor and qualify all structurally similar devices produced by the same process and production during that period. A summary of these test results is available on request at the time of order placement.

All of the applicable Electrica! Parameters of Table IIIA are per formed at pretest on the Table lllC samples. This provides the MIL-STD-883 electrical parameter and design verification Group A tests. These tests are performed on representative circuit types from every die process family type in manufacturing during this period.

Table IIIB consists of the package oriented qualification environmental stress tests of MIL-STD-883, Groups B and C. Representative samples from each package product family type are monitored and qualified every 90 day period by these tests. A common device is used as the die type for these package and assembly qualification tests.

Table IIIC consists of the die process oriented qualification electrical stress or operational tests at high temperature per MIL-STD-883, Groups B and C. Representative devices from each die process family are monitored and qualified every 90 day period by these tests. The package type is randomly selected as applicable.

An additional screening series is available at extra cost. Details are given in Table $V$, MIL-STD-883, method 5004, high reliability screening.

Table I - 100\% Production Screen Tests

| TEST | CONDITIONS |
| :--- | :--- |
| Preseal Visual | High Power - Low Power <br> Liquid to Liquid, 5 Cycles, 60 Seconds <br> at $0^{\circ} \mathrm{C}, 60$ Seconds at $100^{\circ} \mathrm{C}$, transfer |
| thermal Shock | Yime 5 Seconds. (See Note 1.) |
| Y Axis; 30,000 g minimum, |  |
| Centrifuge minute. (See Note 1.) |  |
| Germeticity | Gross leak test (Bubble Test). <br> (See Note 1.) |
| Production Electrical <br> Tests |  |

*Systematic Uniformity and Reliability Evaluation

Table II - Signetics Acceptance Tests (See Notes 2 and 3)

| SIGNETICS SUBGROUP | TEST | CONDITIONS | AQL | MIL-STD-105 INSPECTION LEVEL |
| :---: | :---: | :---: | :---: | :---: |
| A. 1 | Visual and Mechanical Inspection | MIL-STD-883 Method 2009 | 1.0\% | III |
| A-2 | DC Parameters | $T_{A}=+25^{\circ} \mathrm{C}$ | 1.0\% | III |
| A. 3 | DC Parameters | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1.0\% | III |
| A. 4 | DC Parameters | $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$ | 1.0\% | II |
| A. 5 | DC Parameters | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ | 1.0\% | III |
| A. 6 | AC Parameters | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1.0\% | III |

## TABLE IIIA. MIL-STD-883 GROUP A

 ELECTRICAL TESTS| $\begin{aligned} & \text { MIL.STD. } 883 \\ & \text { GROUP A } \\ & \text { SUBGROUP } \end{aligned}$ | SIGNETICS SUBGROUP | TEST DESCRIPTION |
| :---: | :---: | :---: |
| A1 | A. $2, ~ A .3$ | Static tests at $25^{\circ} \mathrm{C}$ |
| A2 | A. 4 | Static tests at maximum rated operating temperature. |
| A3 | A. 5 | Static tests at minimum rated operating temperature. |
| A4 | A 6 | Dynamic tests at $25^{\circ} \mathrm{C}$, |
| A5 | C 2, when applicable | Dynamic tests at maximum rated operating temperature. |
| A6 | C 2, when applicable | Dynamic tests at minimum rated operating temperature. |
| A 7 | * | Functional tests at $25^{\circ} \mathrm{C}$. |
| A8 | A 4, A 5 | Functional tests at maximum and minimum rated operating temperatures. |
| A9 | A 6 | Switching tests at $25^{\circ} \mathrm{C}$. |
| A 10 | C 2, when applicable | Switching tests at maximum rated operating temperature. |
| A 11 | C 2, when applicable | Switching tests at minimum rated operating temperature. |

TABLE IIIB. MIL-STD-883 GROUPS B AND C ENVIRONMENTAL TESTS

| MIL-STD-883 GROUP B \& C SUBGROUP | TEST DESCRIPTION | MIL-STD-883 METHOD | CONDITIONS | LTPD |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{B}_{1}$ | Physical Dimensions | 2008 | Test Condition A | 15 |
| $\mathrm{B}_{2}$ | Marking Permanency Visual and Mechanical Bond Strength | $\begin{aligned} & 2008 \\ & 2008 \\ & 2011 \\ & \hline \end{aligned}$ | Test Condition B, Para. 3,2,1 <br> Test Condition B <br> Test Condition D | 4 devices/no fallure 1 device/no fallure 15 |
| $\mathrm{B}_{3}$ | Solderability | 2003 | Solder Temperature $260^{\circ} \mathrm{C} \pm 10^{\circ} \mathrm{C}$ | 15 |
| $\mathrm{B}_{4}$ | Lead Fatigue Hermeticity <br> a. Fine <br> b. Gross | $\begin{aligned} & 2004 \\ & 1014 \end{aligned}$ | Test Condition $\mathrm{B}_{2}$ <br> See Note 4 <br> Test Condition A or B <br> Test Condition C | 15 |
| $\mathrm{C}_{1}$ | Pre.Test Electrical <br> Parameters <br> Thermal Shock <br> Temperature Cycle <br> Morsture Resistance <br> End Point Electrical <br> Parameters <br> failure criteria | $\begin{aligned} & 1011 \\ & 1010 \\ & 1004 \end{aligned}$ | Signetics Subgroup A-3 <br> 15 Cycles. Test Condition C, <br> $+150^{\circ} \mathrm{C}$ to $-65^{\circ} \mathrm{C}$ <br> 10 Cycles. Test Condition C , <br> $150^{\circ} \mathrm{C}$ to $-65^{\circ} \mathrm{C}$ <br> Omit initial conditioning. <br> Signetics Subgroup A•3 <br> Refer to Table IV. | 15 |
| $\mathrm{C}_{2}$ | Pre.Test Electrical <br> Parameters <br> Mechanical Shock <br> Vibration Variable <br> Frequency <br> Constant Acceleration <br> End Point Electrical <br> Parameters <br> FAILURE CRITERIA | $\begin{aligned} & 2002 \\ & 2007 \\ & 2001 \end{aligned}$ | Signetics Subgroup A. 3 <br> Test Condition B <br> Test Condition A <br> Test Condition E <br> Signetics Subgroup A•3 <br> Refer to Table IV. | 15 |
| $\mathrm{C}_{3}$ | Salt Atmosphere | 1009 | Test Condition A. Omit initial conditioning. | 15 |
| $\mathrm{C}_{4}$ | Pre-Test Electrical <br> Parameters <br> High Temperature <br> Storage <br> End Point Electrical <br> Parameters <br> FAILURE CRITERIA | 1008 | Signetics Subgroup A. 3 $T_{A}=+150^{\circ} \mathrm{C}, \mathrm{t}=1000 \text { hours }$ <br> Signetics Subgroup A. 3 Refer to Table IV. | $\lambda=15$ |

TABLE IIIC. MIL-STD-883 GROUPS B AND C HIGH TEMPERATURE OPERATING LIFE TESTS

| MIL-STD-883 GROUP B \& C SUBGROUP | TEST DESCRIPTION | MIL.STD-883 METHOD | CONDITIONS | LTPD |
| :---: | :---: | :---: | :---: | :---: |
|  | Pre-Test aind Design <br> Verification Electrical <br> Parameters |  | Table IIIA as applicable, data sheet groups A \& C. |  |
| $\mathrm{C}_{6}$ | High Temperature Steady <br> State Reverse Bias <br> End Point Electrical <br> Parameters <br> FAILURE CRITERIA | 1015 | Test Condition A $\mathrm{T}_{\mathrm{A}}=150^{\circ} \mathrm{C}$ $t=72$ hours. <br> Signetics Subgroup A. 3 <br> Reter to Table IV | $\lambda=10$ |
| $B_{5}$ \& C5 | High Temperature Operating Life <br> End Point Electrical Parameters FAILURE CRITERIA | 1005 | Test Condition D or E as applicable. <br> $T_{A}=+125^{\circ} \mathrm{C}$ or $+85^{\circ} \mathrm{C}$, per Part <br> Data Sheet. $t=1000$ hours. <br> Signetics Subgroup A. 3 <br> Reter to Table IV. | $\lambda=10$ |

[^8]Table IV - Signetics Failure Criteria

| TEST | $" 1 "$ Input Current | $" 1 "$ Output Voltage | $" 0$ " Input Current | $" 0 "$ Output Voltage | Expansion Node Current |
| :---: | :--- | :--- | :--- | :--- | :--- |
| LIMITS | Data Sheet Limits and: <br> $10 \times$ Initial Value for DTL <br> $5 \times$ Initial Value for TTL | Data Sheet Limits and <br> $\pm 20 \%$ Initial Value | Data Sheet Limits <br> $\pm 20 \%$ Initial Value | Data Sheet Limits and <br> $\pm 0.1 V$ | Data Sheet Limits and <br> $\pm 20 \%$ |

## Optional High Reliability Screening

To maximize reliability in critical application, the Optional High Reliability Screening of Table $V$ provides for three levels of $100 \%$ screening per MIL-STD-883. Method 5004 at extra cost. This series eliminates the necessity for special specification, minimizes cost and provides the shortest possible delivery time. This series is applied after the normal Group $A$ acceptance test. Circuits subjected to this Preconditioning Series are clearly distinguishable from standard products in the following ways:

1. Individual serial number on each circuit (Class $A$ only).
2. The first letters of a part number are either RA, RB, or RC.
```
RA = Class A
RB = Class B
RC=Class C
i.e., RA8880J = 100% screening of Table V, Class A.
```

3. Individual device variables parametric test data is supplied with each shipment (Class A only).

Consult your local representative for price information. Device types should be specified with the appropriate tetter prefixes.

## Notes:

1. Not applicable to solid molded packaged devices.
2. All test equipment calibrated to meet requirements of MIL-Q.9858A and MIL.C.45662A.
3. Detailed tests, conditions, and limits applicable to each subgroup are given in the Signetics data sheet ELECTRICAL CHARACTERISTICS table. See Table IllA for the corresponding Group $A$ tests of MIL-STD. 883.
4. The Hermeticity tests are not employed for solid molded packages.
5. Class $B$ and Class $C$ may be subjected to thermal shock as an alternate.
6. The test sequence of fine and gross leak may be reversed when fluorocarbons are utilized for gross leak.
7. The individual MIL-STD-883 Test Methods are, in many cases designed to "stand alone" as a sole screen or sole Group B environmental sampling test. But since 5004 specifies a screening series or flow, some of the measurements, etc., specified in an individual Test Method are not intended to be applicable in the screening series.

TABLE V - MIL-STD-883 METHOD 5004, HIGH RELIABILITY SCREENING

| TEST | MIL-STD. 883 METHOD | CLASS A | CLASS B | CLASS C | CLARIFICATIONS (See Note 7) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Internal Visual (preseal) | 2010.1 | Cond A | Cond. B | Cond. B | Test Condition A, Paragraph 3.1.1.7, a, delete the words "and parameter" |
| Stabilization Bake | 1008 (24 hours) | Cond. C | Cond. C | Cond. C | Condition $\mathrm{C}\left(150^{\circ} \mathrm{C}\right)$ max. for au/al metallization system. Cond. $\mathrm{O}\left(200^{\circ} \mathrm{C}\right)$ max. for al/al metalization system. No electrical measurements at this point. |
| Thermal Shock | 1011 | Cond C | Not required. NOTE 5 | Not required. note 5 | Cond. C $\left(150^{\circ} \mathrm{C}\right)$ max. for au/al metallization systern. Cond. $\mathrm{O}\left(200^{\circ} \mathrm{C}\right)$ max. for al/al metallization system. No electrical measuraments, no external visual inspection at this point. |
| Tomperature Cycling | 1010 | Cond. C | Cond C NOTE 5 | Cond. C NOTE 5 | $\left(150^{\circ} \mathrm{C}\right)$ max. for su/al metallization system. Cond. D $\left(200^{\circ} \mathrm{C}\right)$ max, for al/al metalization system No electrical measurements, no external visual inspection, no hermoticity tests at this point. |
| Mechanical Shock | 2002, Y 1 plane only | Cond. B | Not Required | Not Required | No electrical measurements at this point. |
| Centrituge | 2001 | Cond E <br> Y2 then $Y 1$ plane | Cond E Y 1 plane | Cond E <br> Y 1 plane |  |
| Hermeticity <br> A. Fine Leak <br> B. Gross Leak | 1014, Note 6 (Hermatic devices only) | Cond. A or B Cond. C | Cond. A or $B$ Cond. C | Cond $A$ or $B$ Cond. C |  |
| Critical Electrical Parameters | Signetics Subgroup A. 3 | Read and Record | Not Requirea | Not Required |  |
| Burn In Test | 1015. $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}$ | 240 hours Cond. D or E (as applicable) | 168 hours Cond. D or E (as applicable) | Not Required |  |
| Critical Electrical Parameters | Signetics Subgroup A 3 | Read and Record | Not Required | Not Required |  |
| Signetics FAILURE CRITERIA |  | Table IV | Not Required | Not Required |  |
| Reverse Bias Burn In | $\begin{aligned} & 1015, \mathrm{~T}_{\mathrm{A}}-+150^{\circ} \mathrm{C} \\ & \mathrm{t}=72 \text { hours } \end{aligned}$ | Cond A or C | Not Required | Not Required | Required only when specified in the applicable procurement document Signetics standard burn in (above) includes reverse bias of unused functions. |
| Final Electrical Test | Perform go no go measurements of Signetics Subgroup. A Parameters | Signetics Subgroups A 2. A 4, A 5, A 6 . Functional tests. truth table when applicable | Stgnetics Subgroups <br> A 2.A 3. A 6. <br> Functional tests. <br> truth table <br> when applicable | Signetics Subgroups A 2, A 3 Functional tesis, truth table when applicable |  |
| Radiographic Inspection | 2012 | $Y$ es | Not Required | Not Required |  |
| External Visual | 2009 | Yes | Yes | Yes |  |

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DENMARK
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## THE NETHERLANDS

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## JAPAN

Asahi Glass Co., Ltd., 1-2 Marunouchi, 2 Chome Chiyoda-ku, Tokyo Phone: 218-5536 TELEX: 4616

## REPRESENTATIVES

## SWEDEN, NORWAY, FINLAND

A. B. Kuno Kallman, Jarntorget 7, S-413 04 Goteborg SV, Sweden Phone 17-01-20 TELEX: 21072

ISRAEL
Rapac Electronics Ltd., P. O. Box 18053, 15 Karl Herbst St., Tel-Baruch, Tel-Aviv Phone: 7771 15,6,7 TELEX: TV 528

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## SWITZERLAND

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Phone: (051) 45-13-00 TELEX: 52012
INDIA
Semiconductors Limited, Radia House, 6, Rampart Row, Fort, Bombay 1
Phone: 293667 TELEX: Transducer, Bombay

## Eyqulits

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[^0]:    Typical Values are for $T_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^1]:    Typical Values are for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^2]:    Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^3]:    Typical Values are for $T_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^4]:    Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^5]:    Typical Values are for $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^6]:    Typical Values are for $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. See Page 3 for Notes.

[^7]:    *Both $Q$ and $\bar{Q}$ remain in " 1 " state until $S_{D}$ or $R_{D}$ rises.

[^8]:    *Signetics performs a truth table test.

